

Characterization and performance of large thin DEPFET detectors

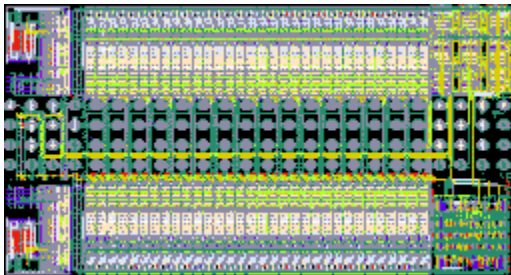
C. Marinas
University of Bonn

DEPFET Collaboration



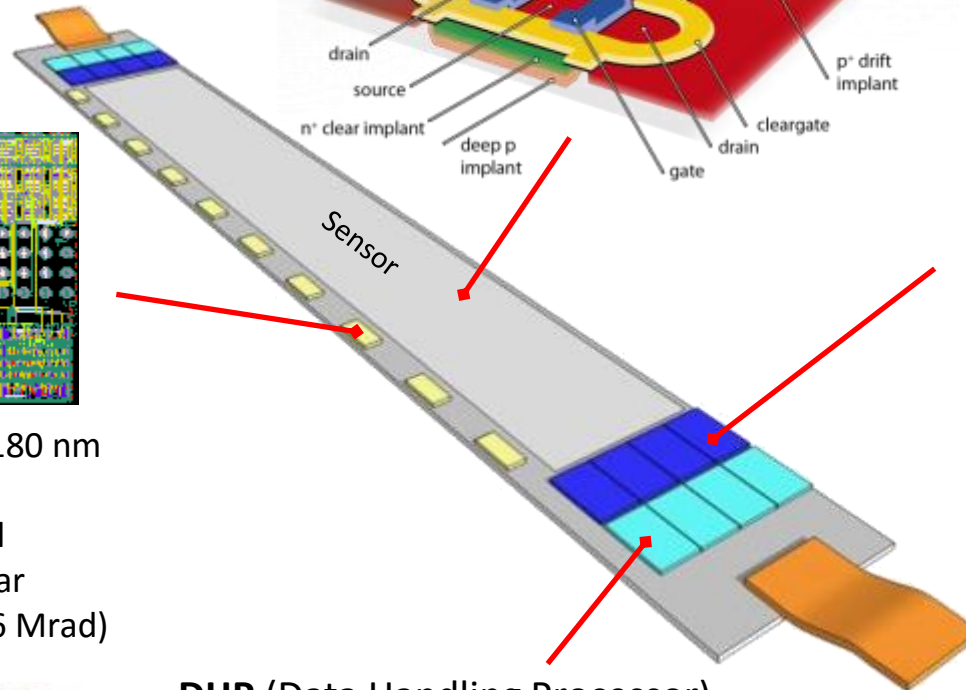
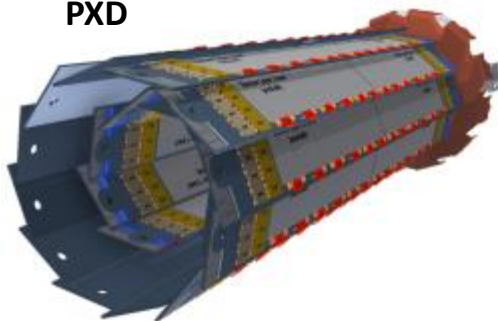
SwitcherB

Row control

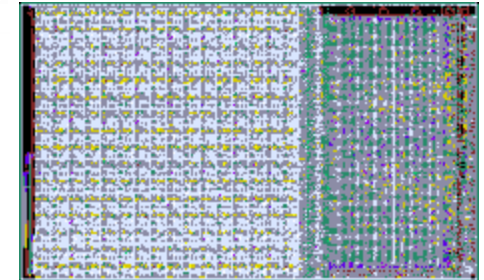


AMS/IBM HVCMOS 180 nm
Size $3.6 \times 1.5 \text{ mm}^2$
Gate and Clear signal
Fast HV ramp for Clear
Rad. Hard proved (36 Mrad)

PXD

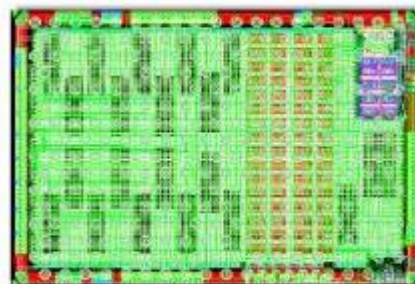


DCDB (Drain Current Digitizer) Analog frontend

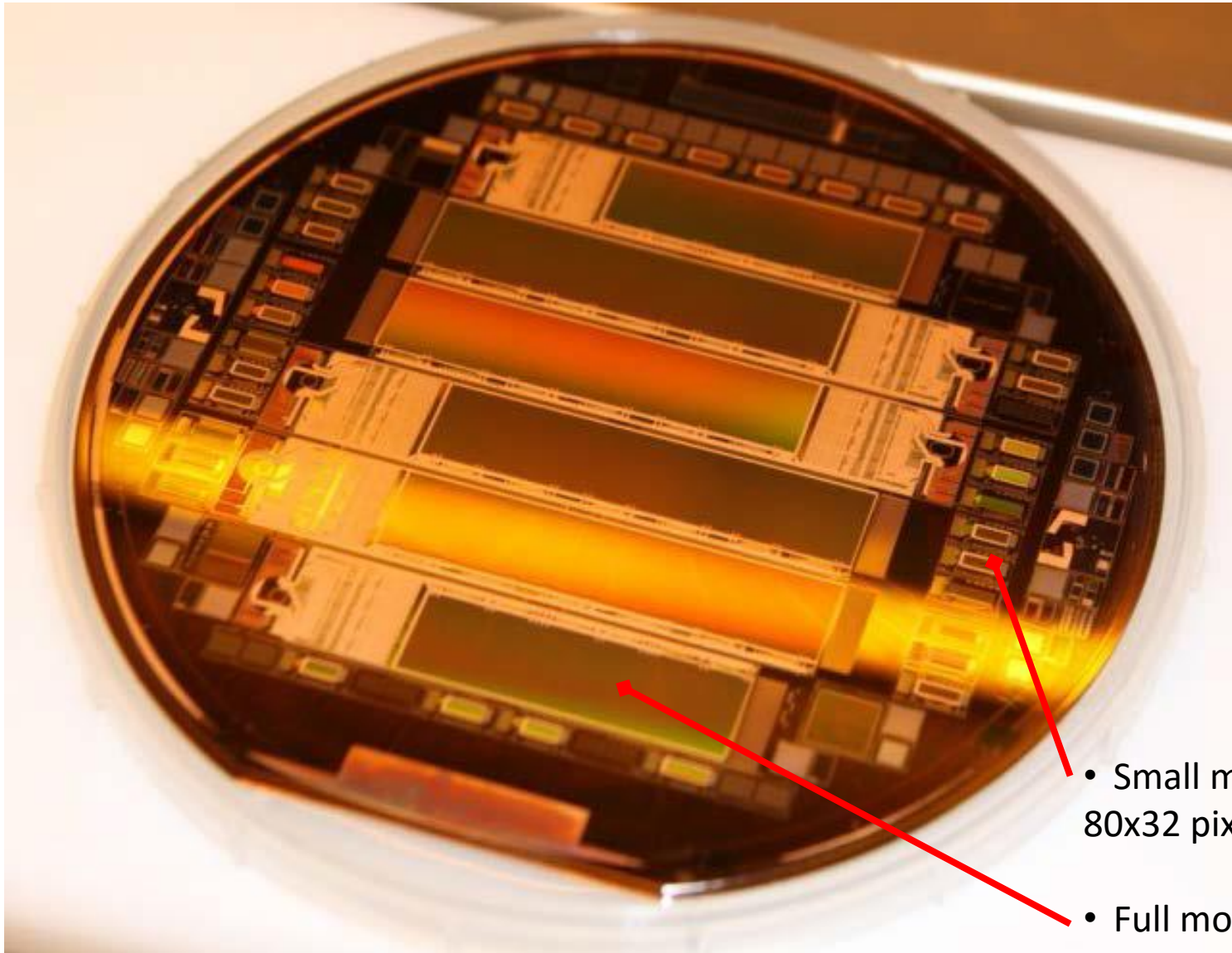


UMC 180 nm
Size $5.0 \times 3.2 \text{ mm}^2$
TIA and ADC
Pedestal compensation
Rad. Hard proved (20 Mrad)

DHP (Data Handling Processor) First data compression



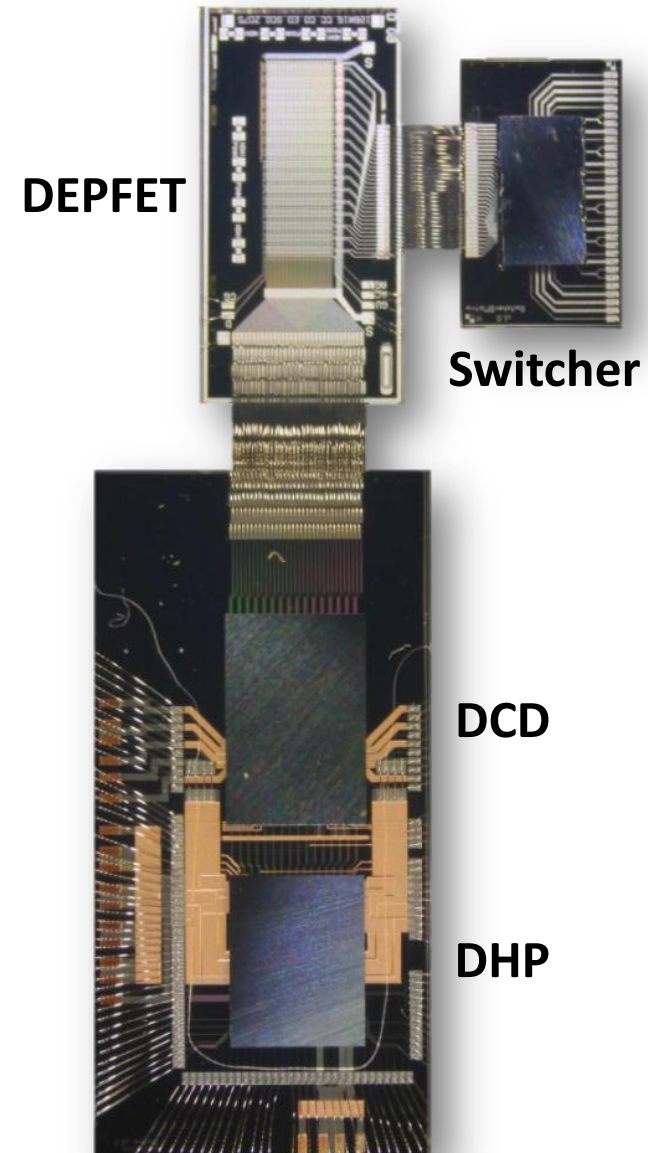
TSMC 65 nm
Size $4.0 \times 3.2 \text{ mm}^2$
Stores raw data and pedestals
Common mode and pedestal correction
Data reduction (zero suppression)
Timing signal generation
Rad. Hard proved (100 Mrad)



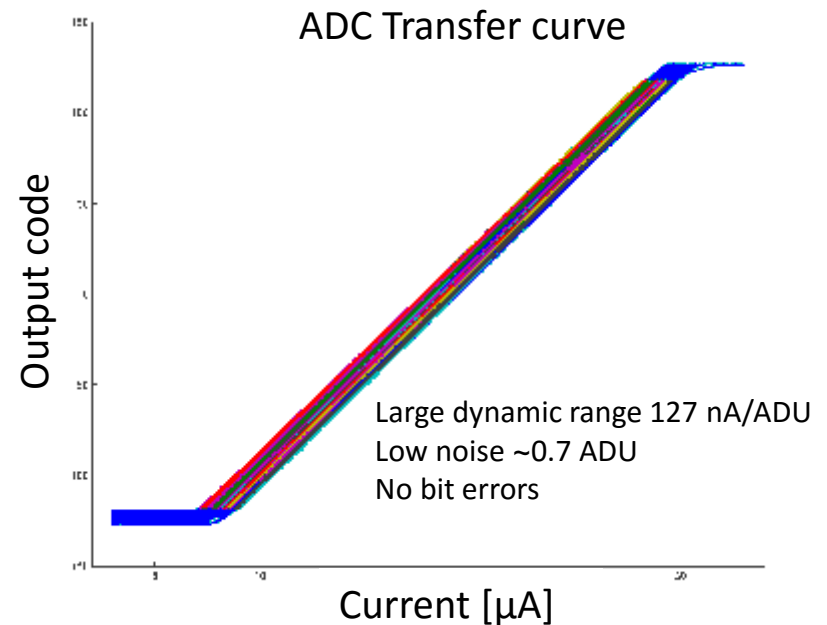
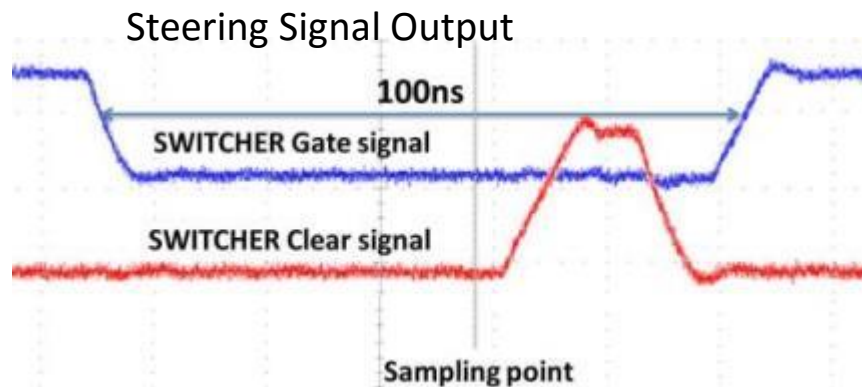
- Small matrices
80x32 pixels

- Full modules with large matrices
768x250 pixels

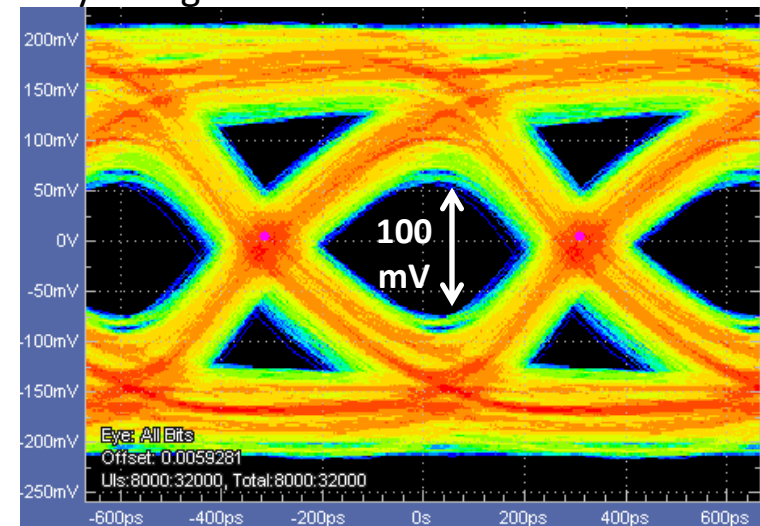
- PXD9 small Belle II type matrix
 - Pixel pitch: $50 \times 55 \mu\text{m}^2$
 - Thinned to $75 \mu\text{m}$
 - Gate length: $5 \mu\text{m}$
 - Thin gate oxide
 - 32×64 pixels readout
- Final readout chain
 - SwitcherB
 - DCDB
 - DHPT
 - DHPT \rightarrow DHH
- DESY Nov 2015:
First Belle II type matrix in a test beam



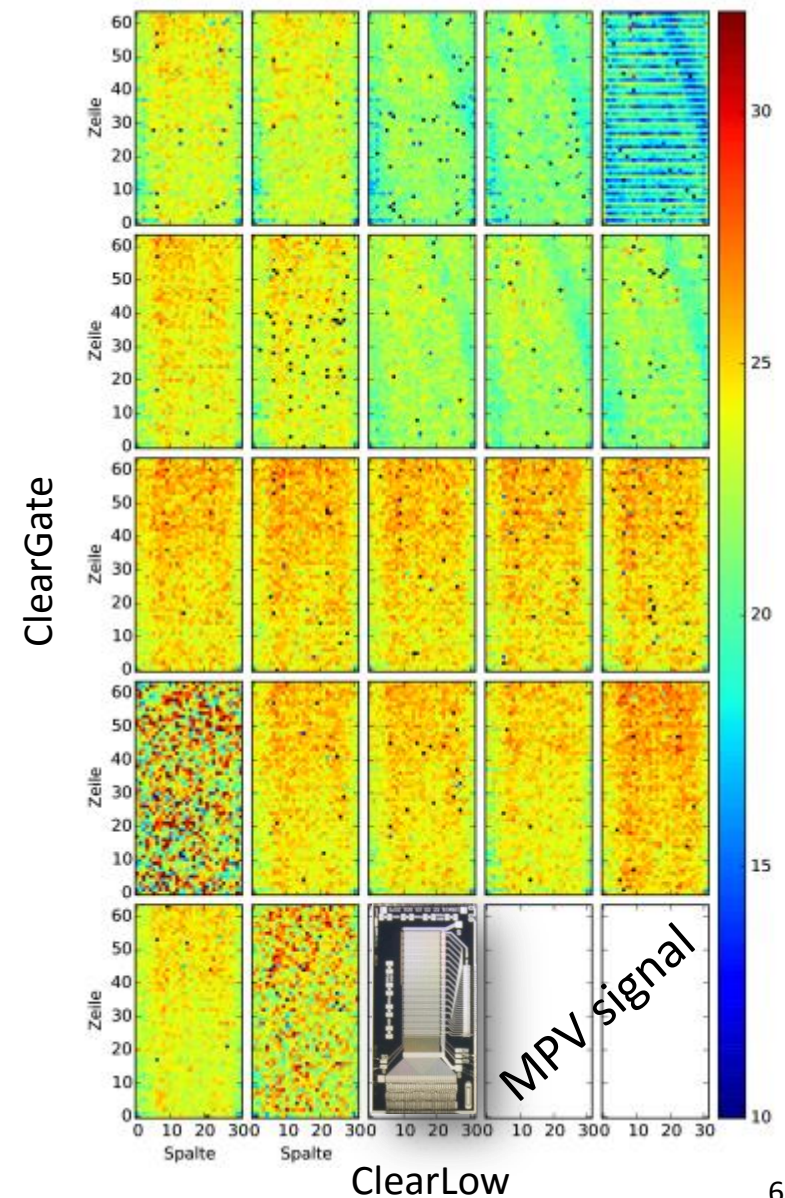
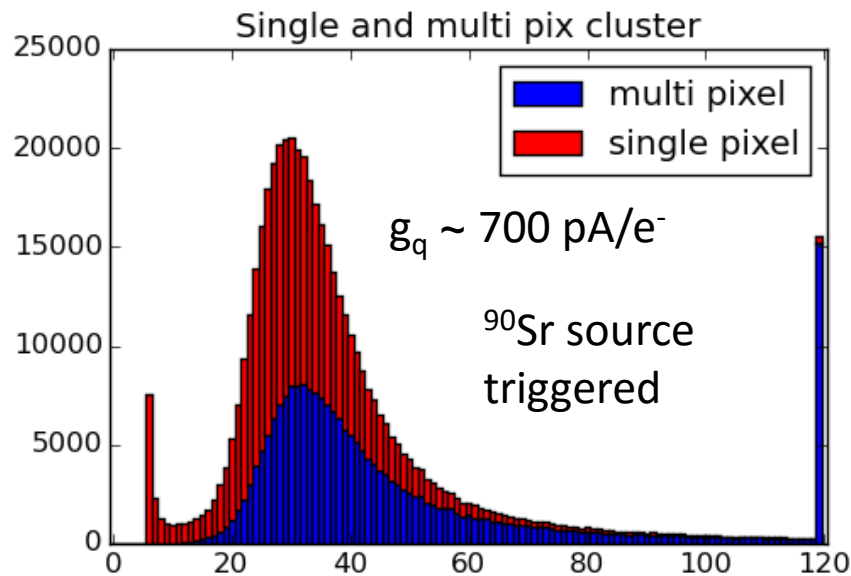
- Drain Current Digitizer (DCD):
 - Uniformity and linearity of ADCs
- Data Handling Processor (DHP):
 - High speed link settings
 - Steering sequences
 - Signal timing
- Interchip communication



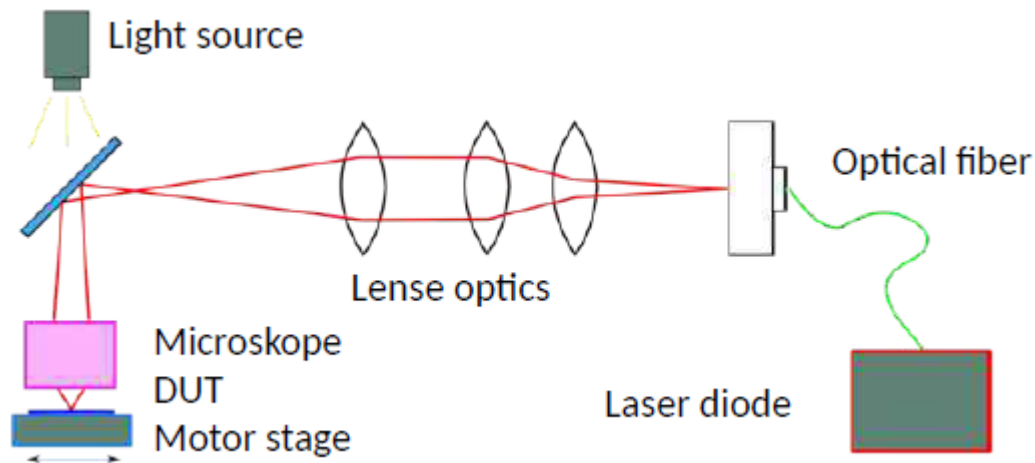
Eye Diagram after 15m cable Cable



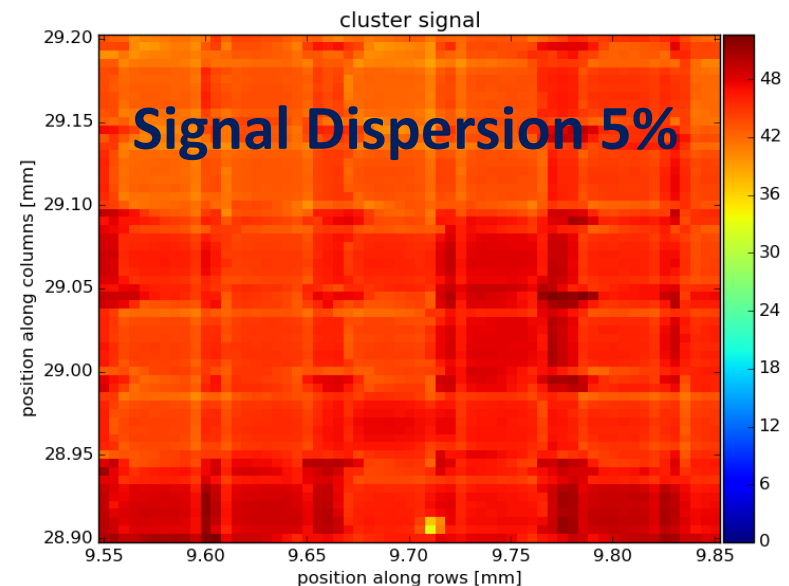
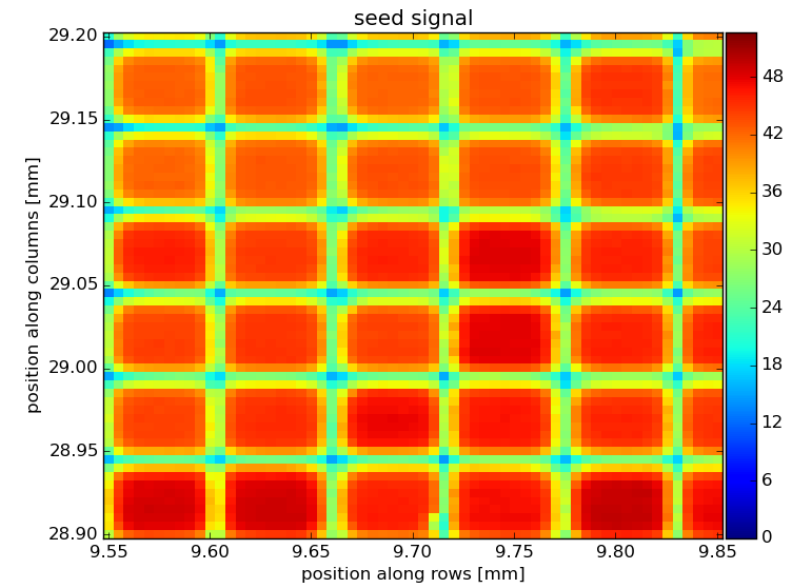
- Optimization of DEPFET voltages
 - Source measurements



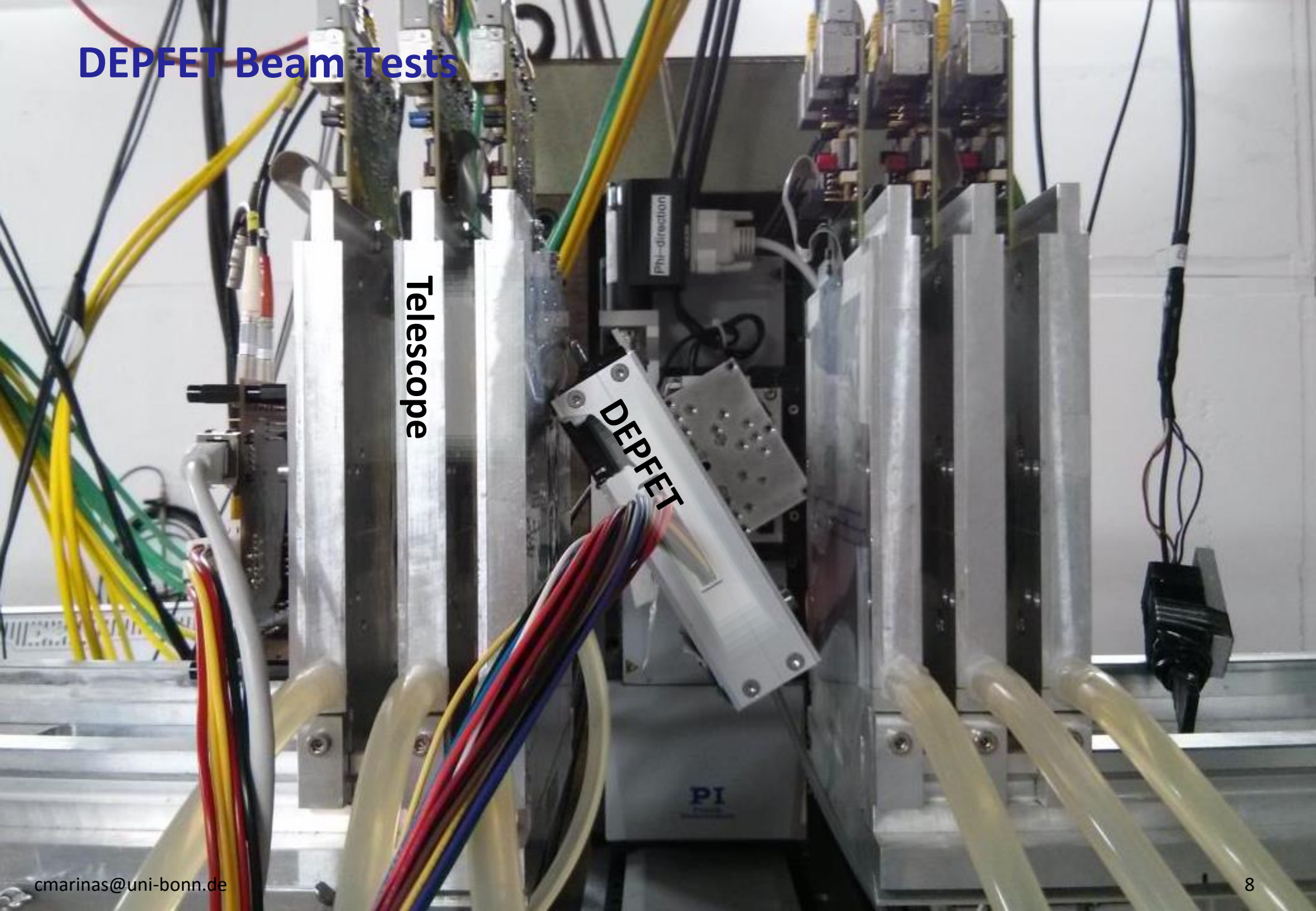
- Optimization of DEPFET voltages
 - Source measurements
 - Laser measurements



- Laser focused through microscope
- $\sim 3 \mu\text{m}$ spot size
- Laser moves over matrix – position resolution



DEPFET Beam Tests

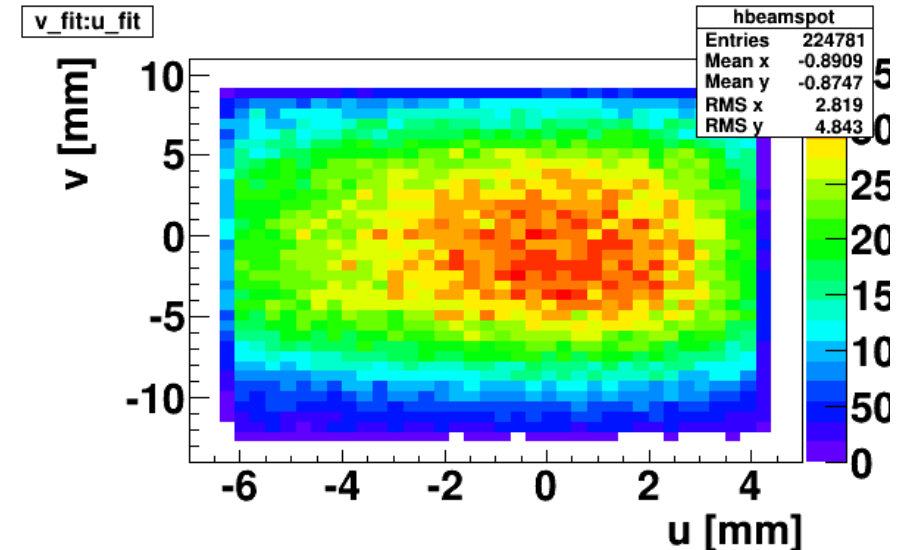
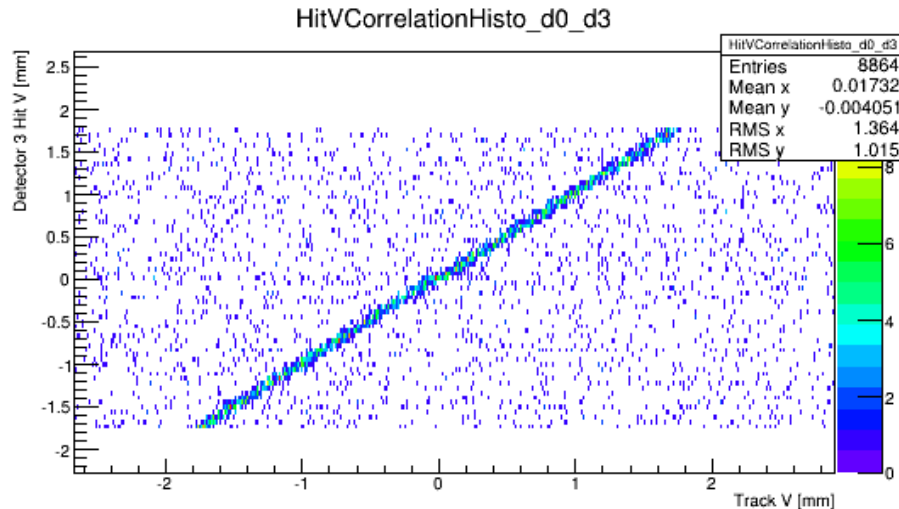


Telescope

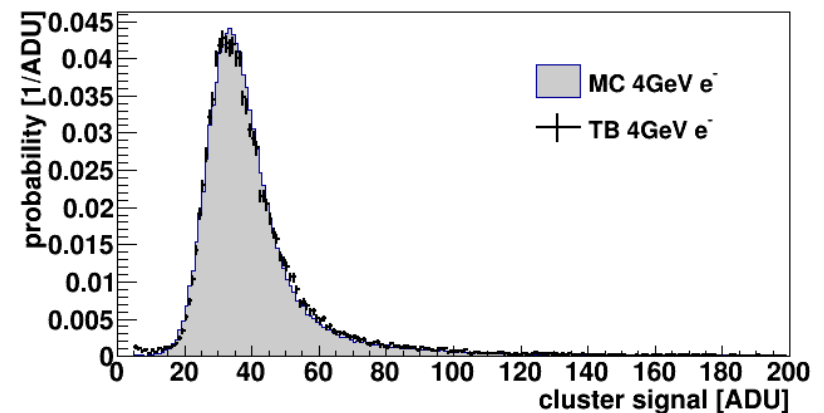
DEPFET

Phi-direction

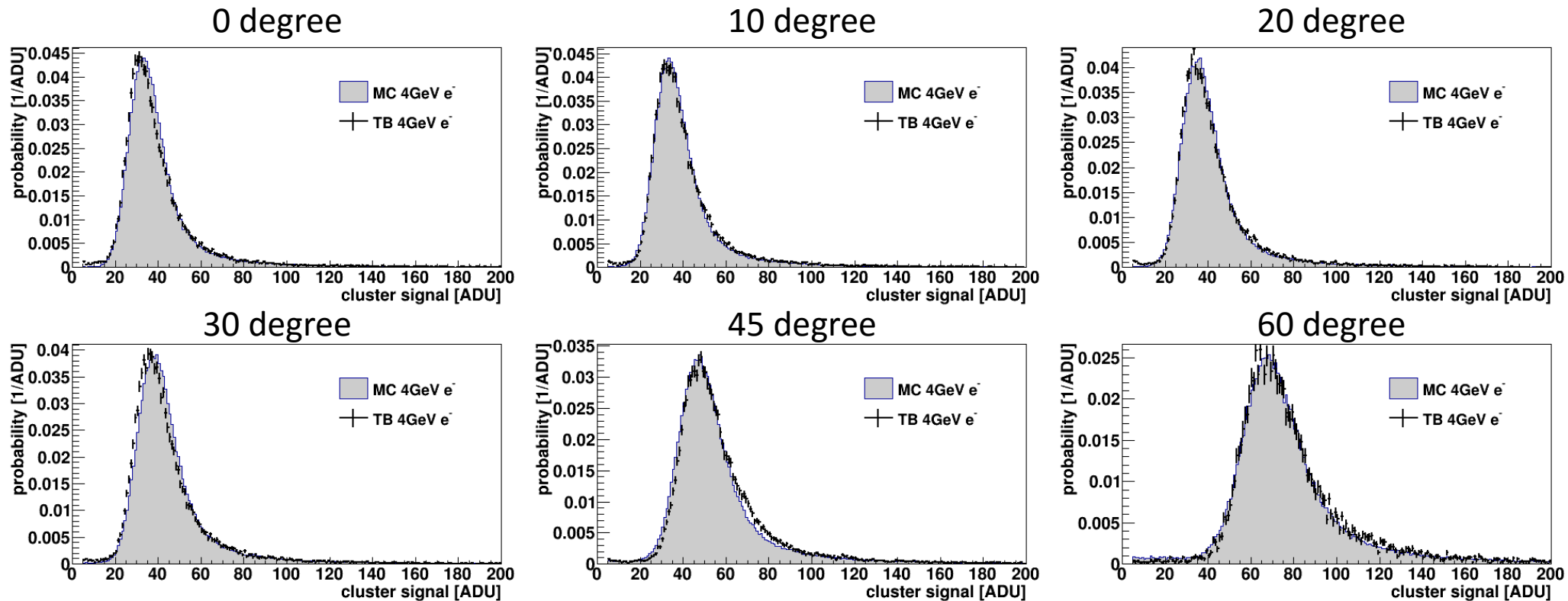
PI



- Correlations with the telescope
 - Beam spot with 4 GeV electrons
 - Landau peak
- Successful integration within few hours time

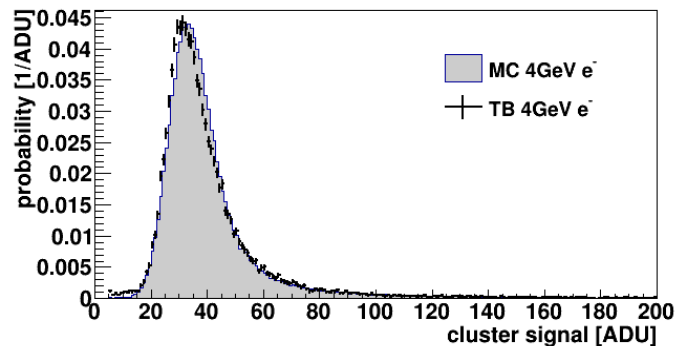


- Measured 4 GeV electrons at different incidence angles
- Checked against Geant4 simulation with DEPFET Clusterizer
- $g_q = 740 \pm 50 \text{ pA/e}^-$ measured

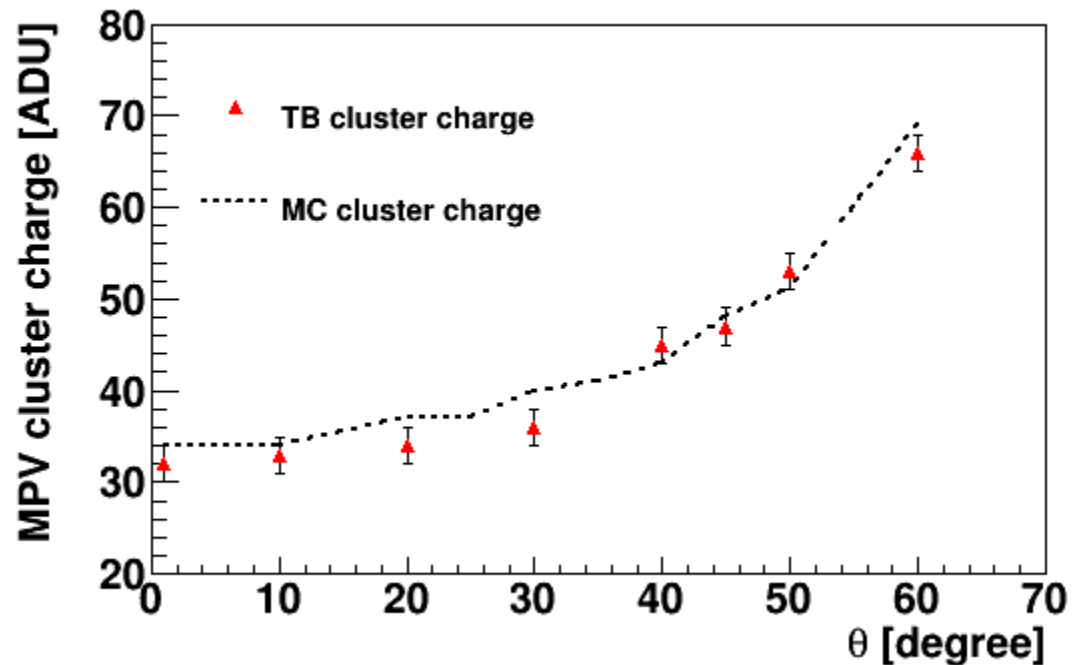
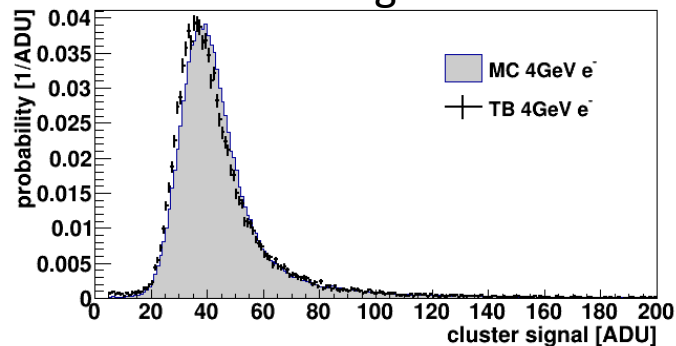


- Measured 4 GeV electrons at different incidence angles
- Checked against Geant4 simulation with DEPFET Clusterizer
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0 degree

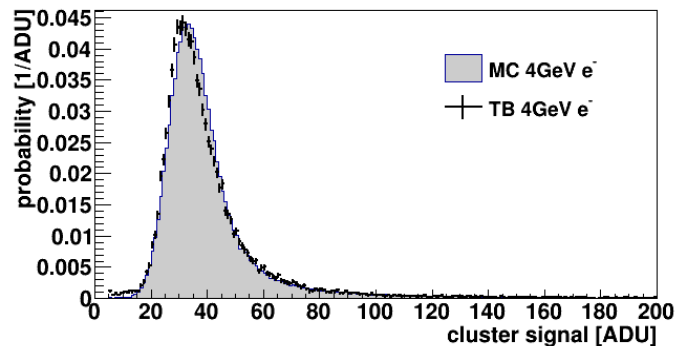


30 degree

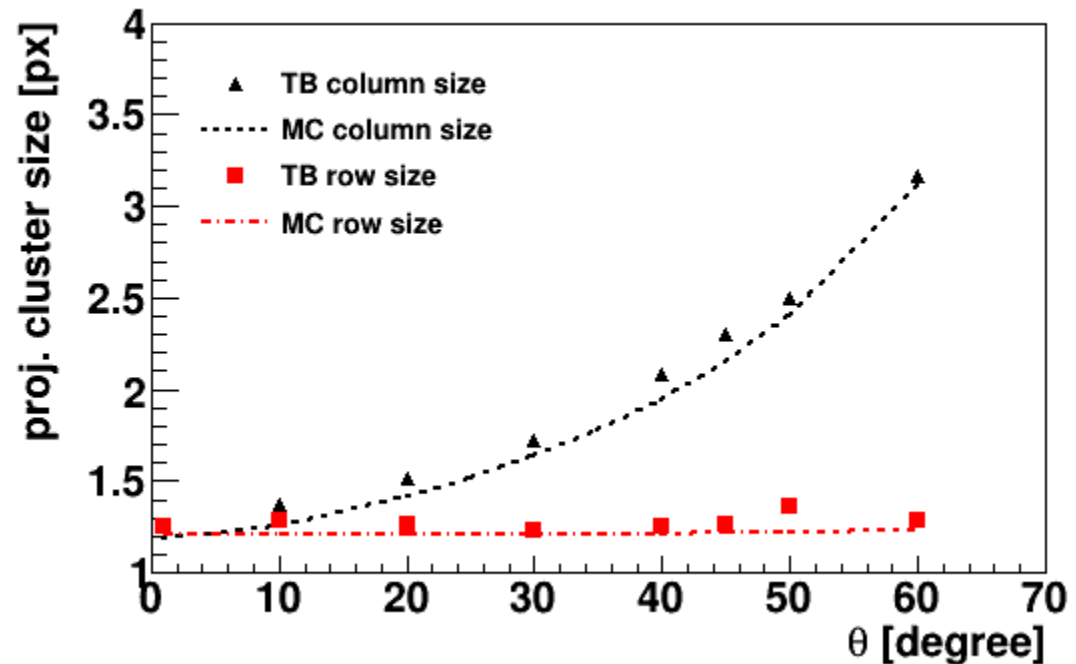
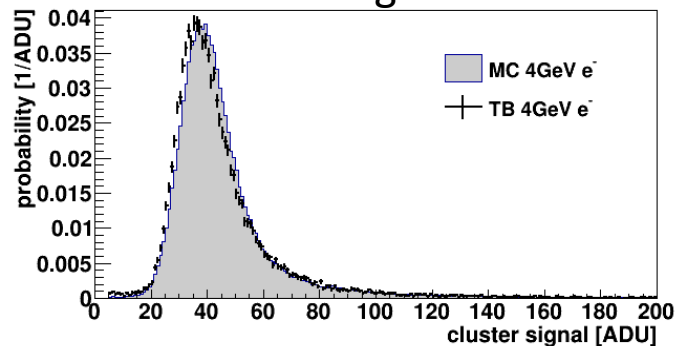


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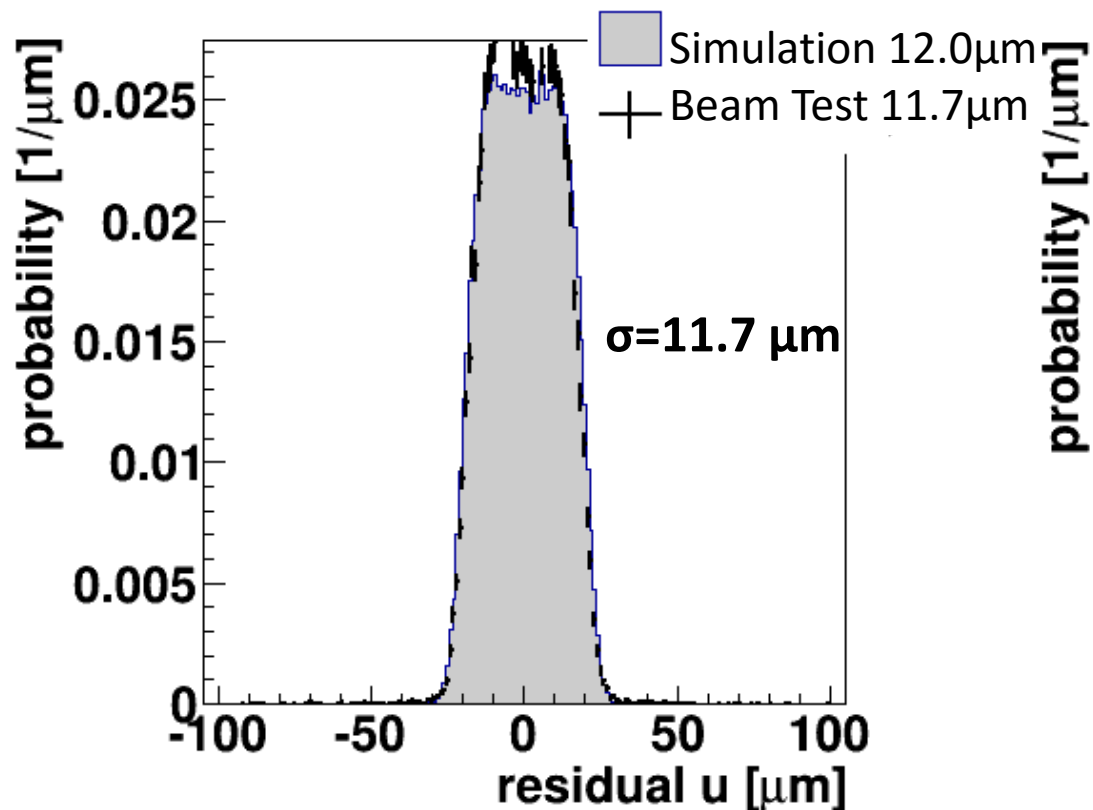
0 degree



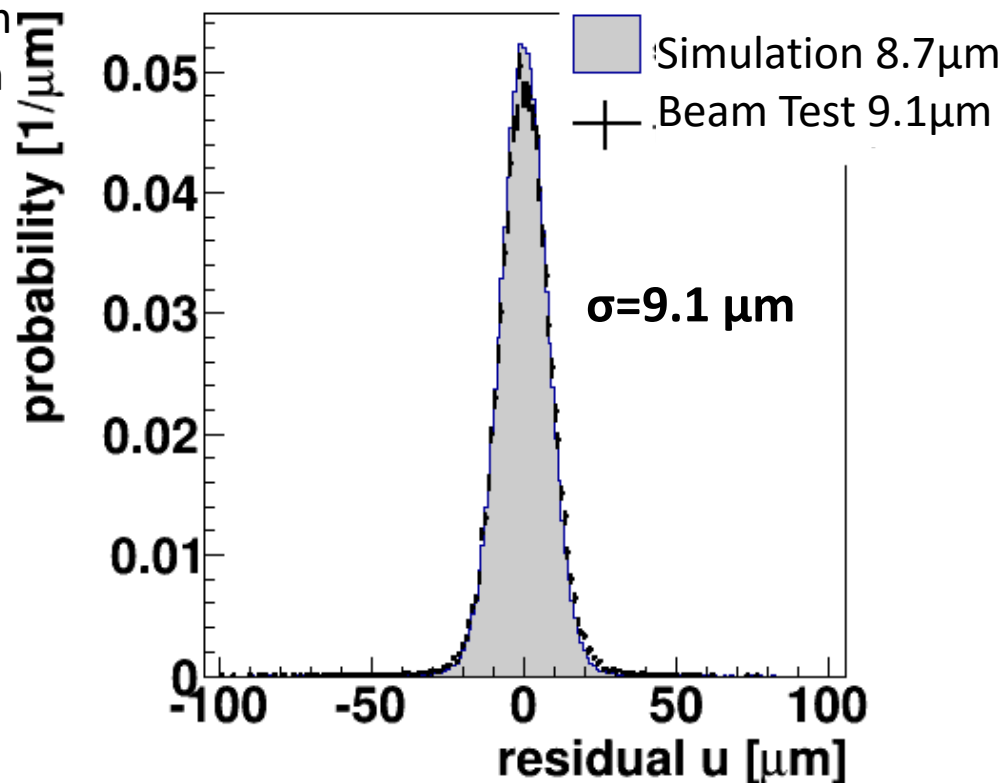
30 degree



0° tilt: perp. incidence



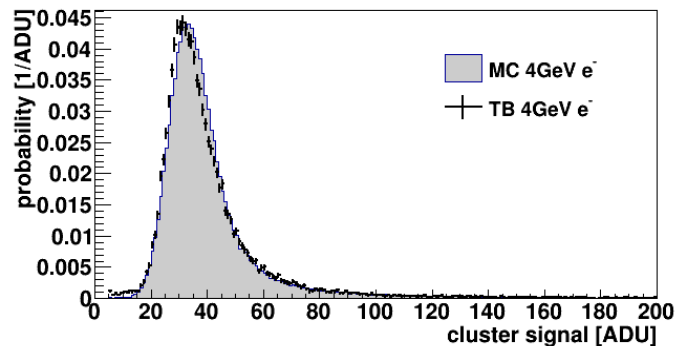
30° tilt: many 2 pixel clusters



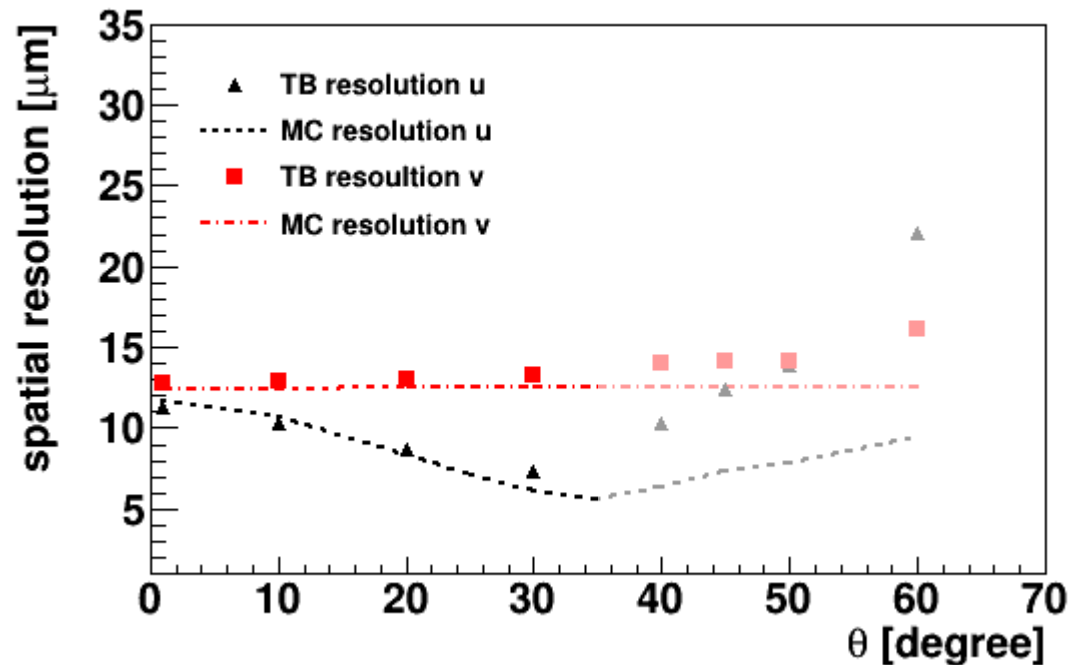
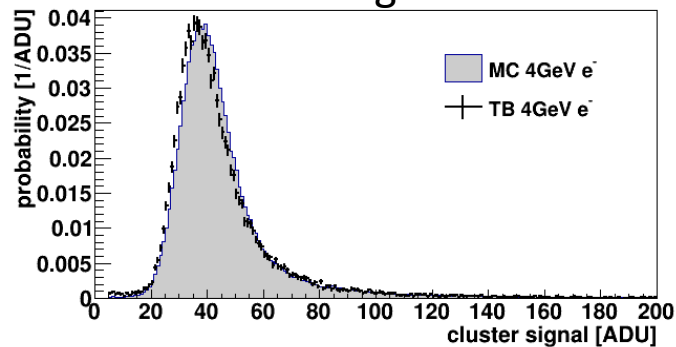
- Matrix tilted along column: multi-column clusters
- Expectation for single pixel readout: $\text{RMS} = 50 \mu\text{m} / \sqrt{12} \approx 14.5 \mu\text{m}$

- Measured 4 GeV electrons at different incidence angles
- Checked against Geant4 simulation with DEPFET Clusterizer
- $g_q = 740 \pm 50 \text{ pA/e}^-$ measured

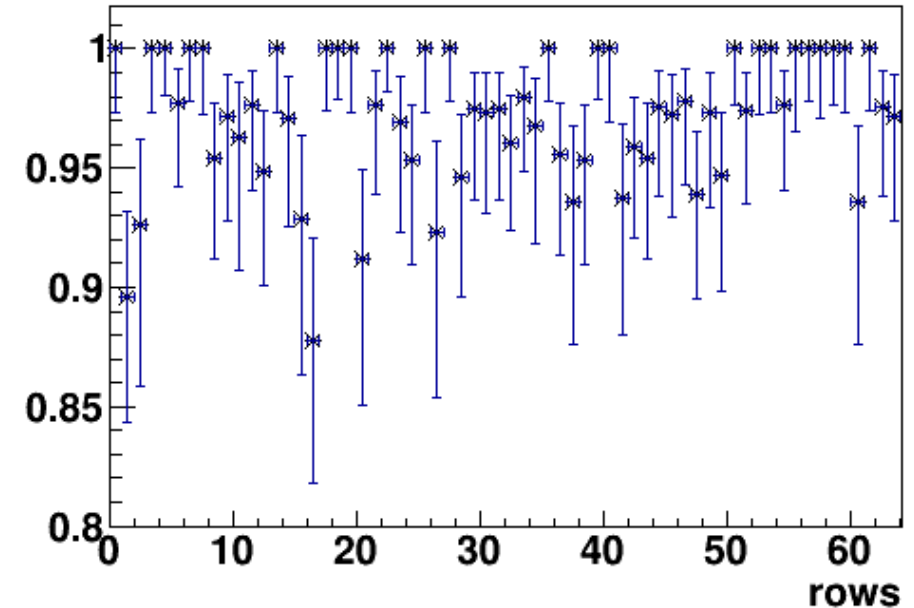
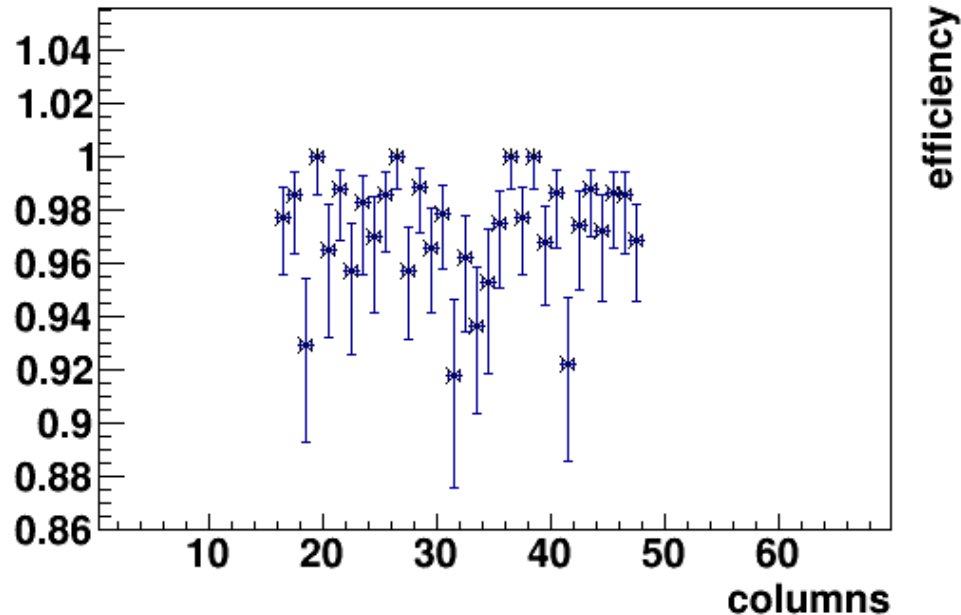
0 degree



30 degree



- Zero Suppression Cut = 5 ADU ($\sim 1000 e^-$)
- 2 noisy (masked) pixels
- Noise occupancy on level $\sim 10^{-5}$



November 2015 test beam:

- First time to see MIPs with PXD9 Belle II thin sensors
- Well trained team: systematic studies and obtain huge statistics
- Results are satisfactory, as expected by design and also according to simulations:
 - Charge collection
 - Cluster size
 - Residuals
 - Efficiency

→ Not mentioned here: Irradiation campaigns, stability tests, other test vehicles

- **Silicon Vertex Detector (SVD)**

4 layers of DSSD

$r = 3.8 \text{ cm}, 8.0 \text{ cm}, 11.5 \text{ cm}, 14 \text{ cm}$

$L = 60 \text{ cm}$

$\sim 1 \text{ m}^2$

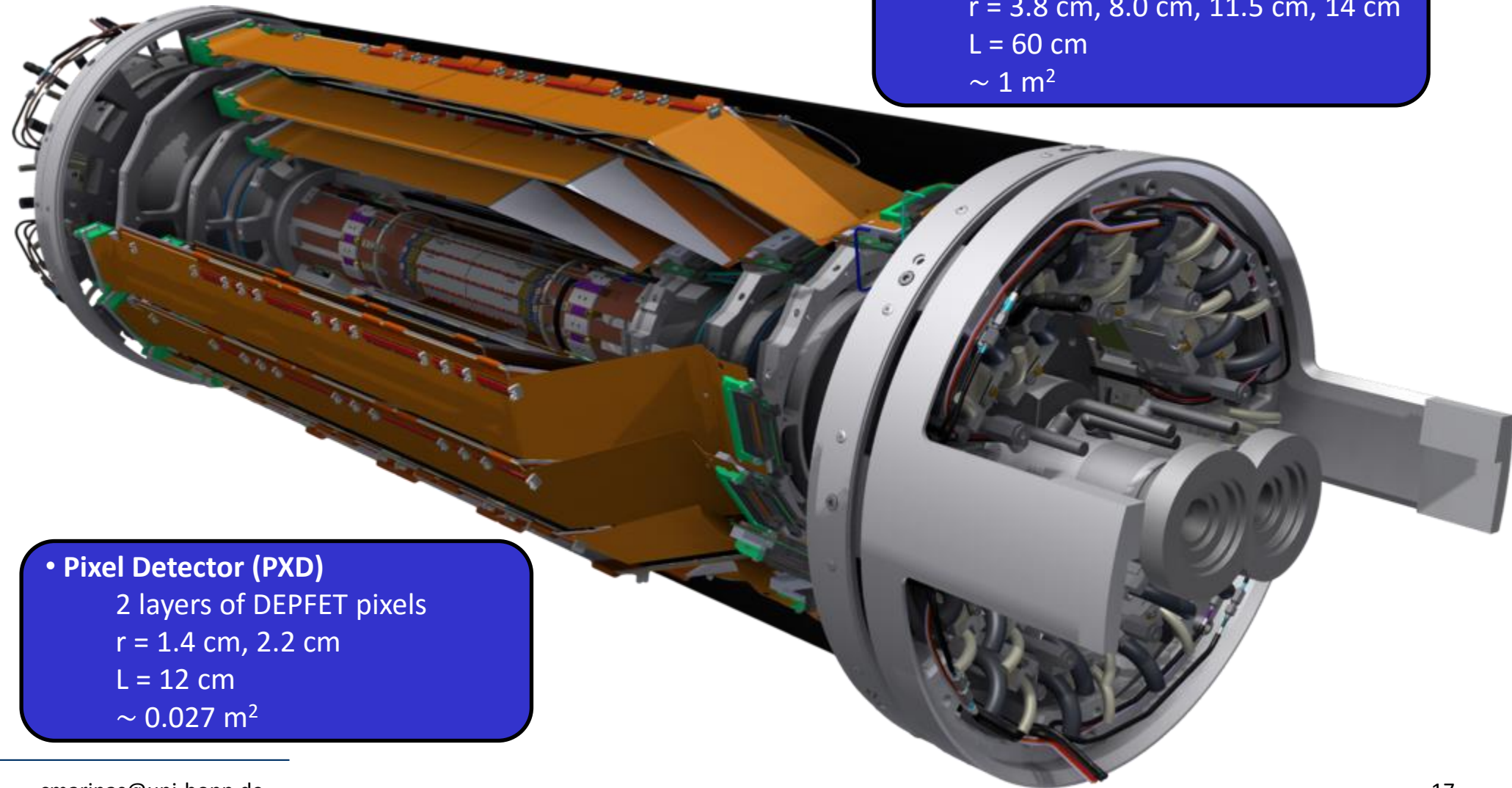
- **Pixel Detector (PXD)**

2 layers of DEPFET pixels

$r = 1.4 \text{ cm}, 2.2 \text{ cm}$

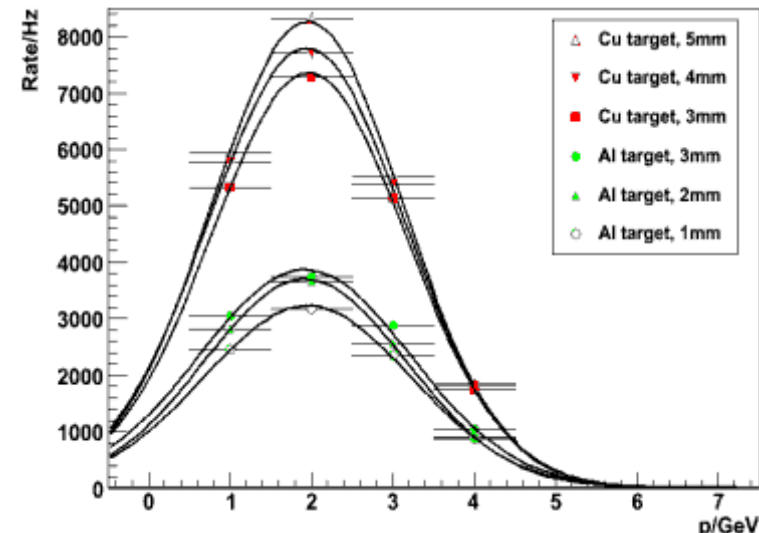
$L = 12 \text{ cm}$

$\sim 0.027 \text{ m}^2$



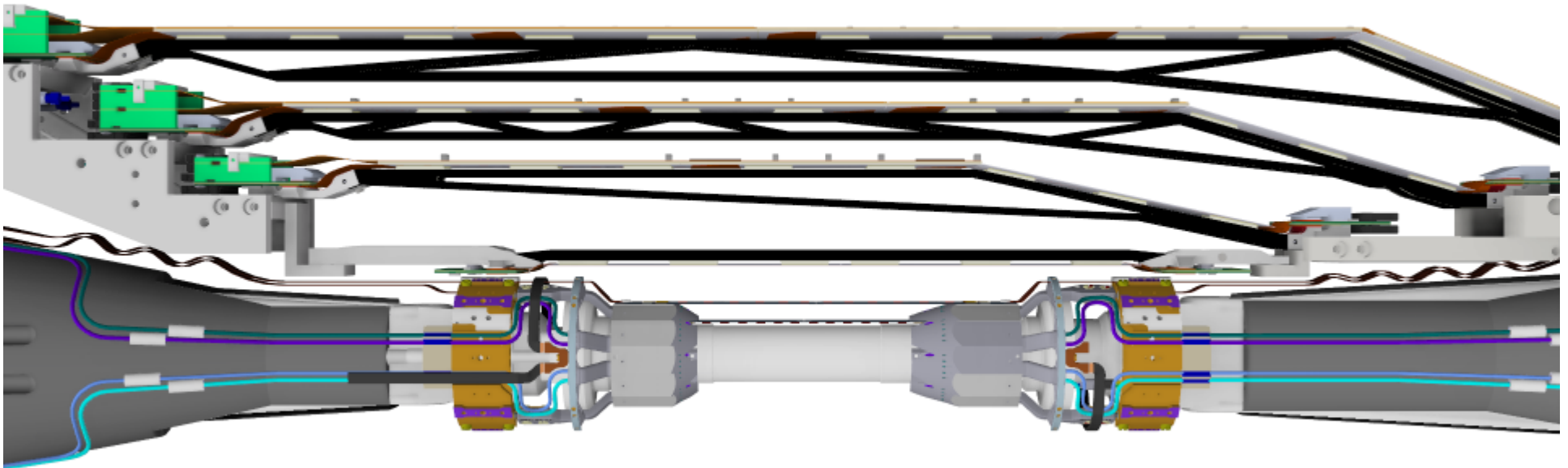
- VXD common test beam in April 2016 (4 weeks)
- Small sector of the final sensors and ASICs*
2 PXD + 4 SVD layers
- Complete DAQ readout chain: HLT, event building
- CO₂ cooling, slow control, monitoring, environmental sensors
- Illumination with (up to) 6 GeV e⁻ under 1T solenoid magnetic field (PCMAG)
- Alignment, tracking algorithms, ROI

■ **Goal: System integration and Phase 2 Commissioning**

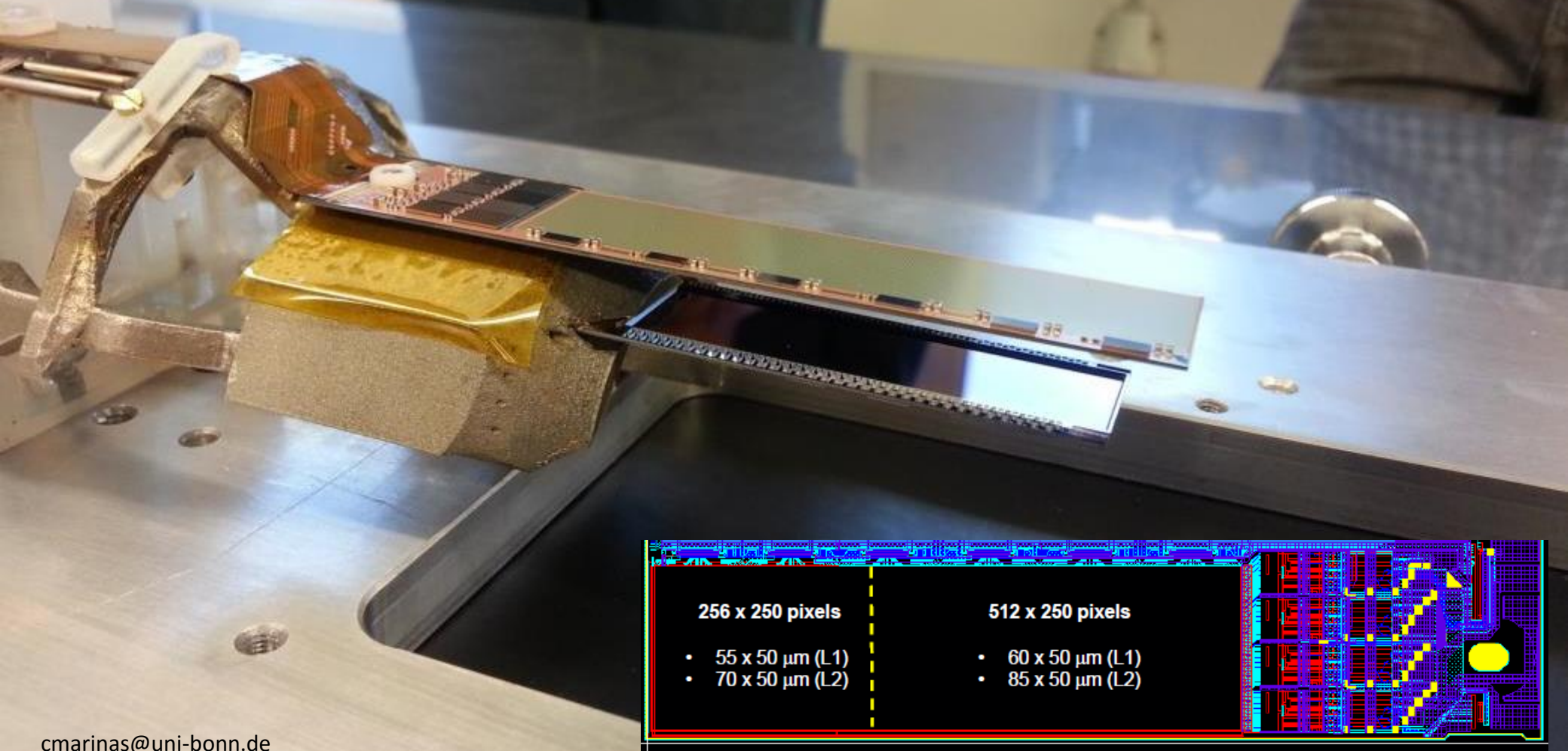


- Two PXD and four SVD layers
- Horizontal plane (highest background sensitivity)

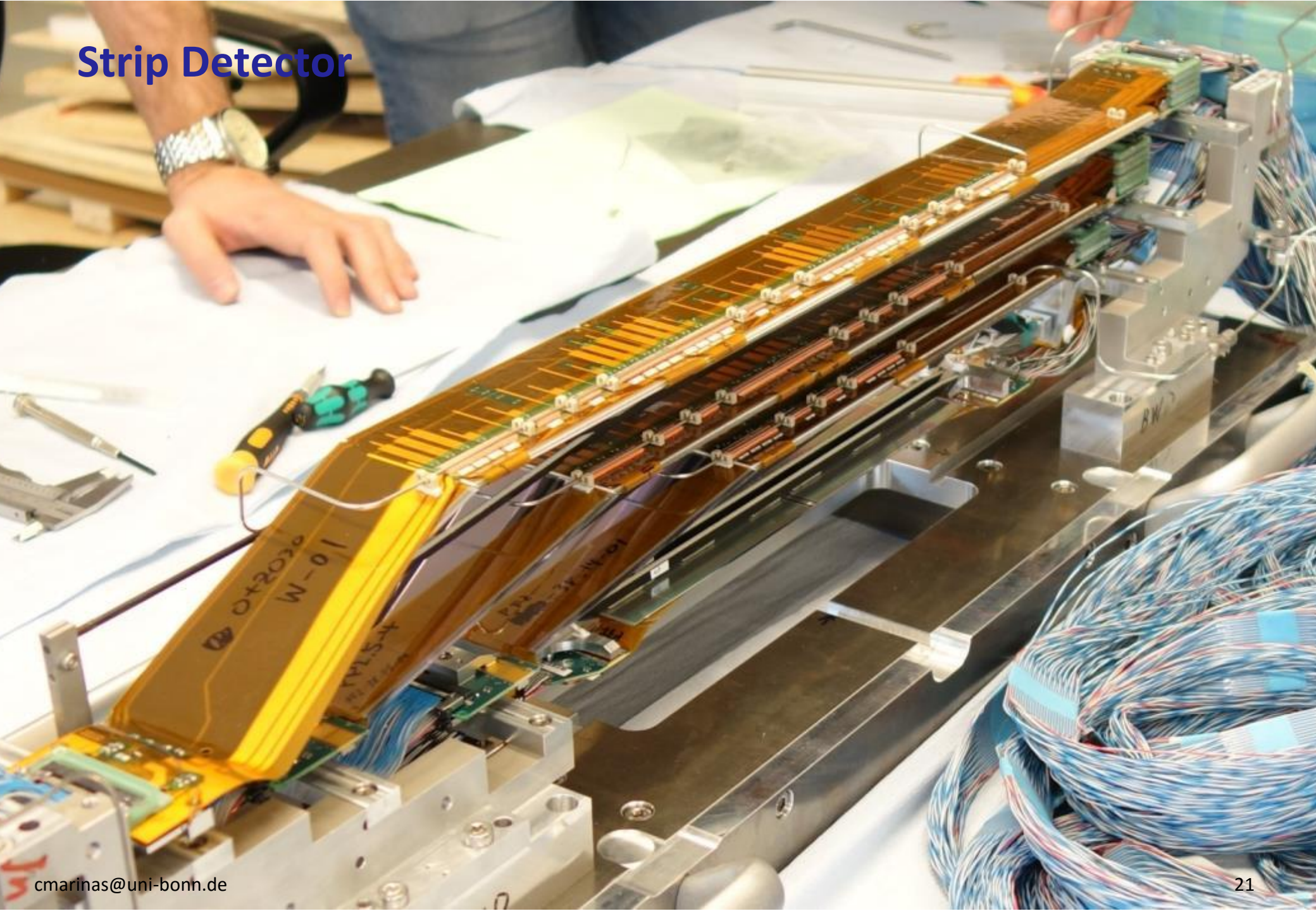
Test Beam set up to mimic commissioning detector arrangement



Pixel Detector



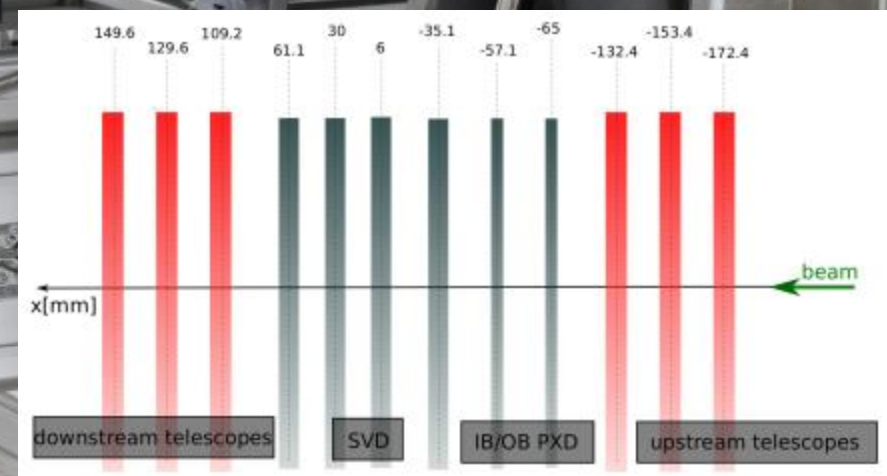
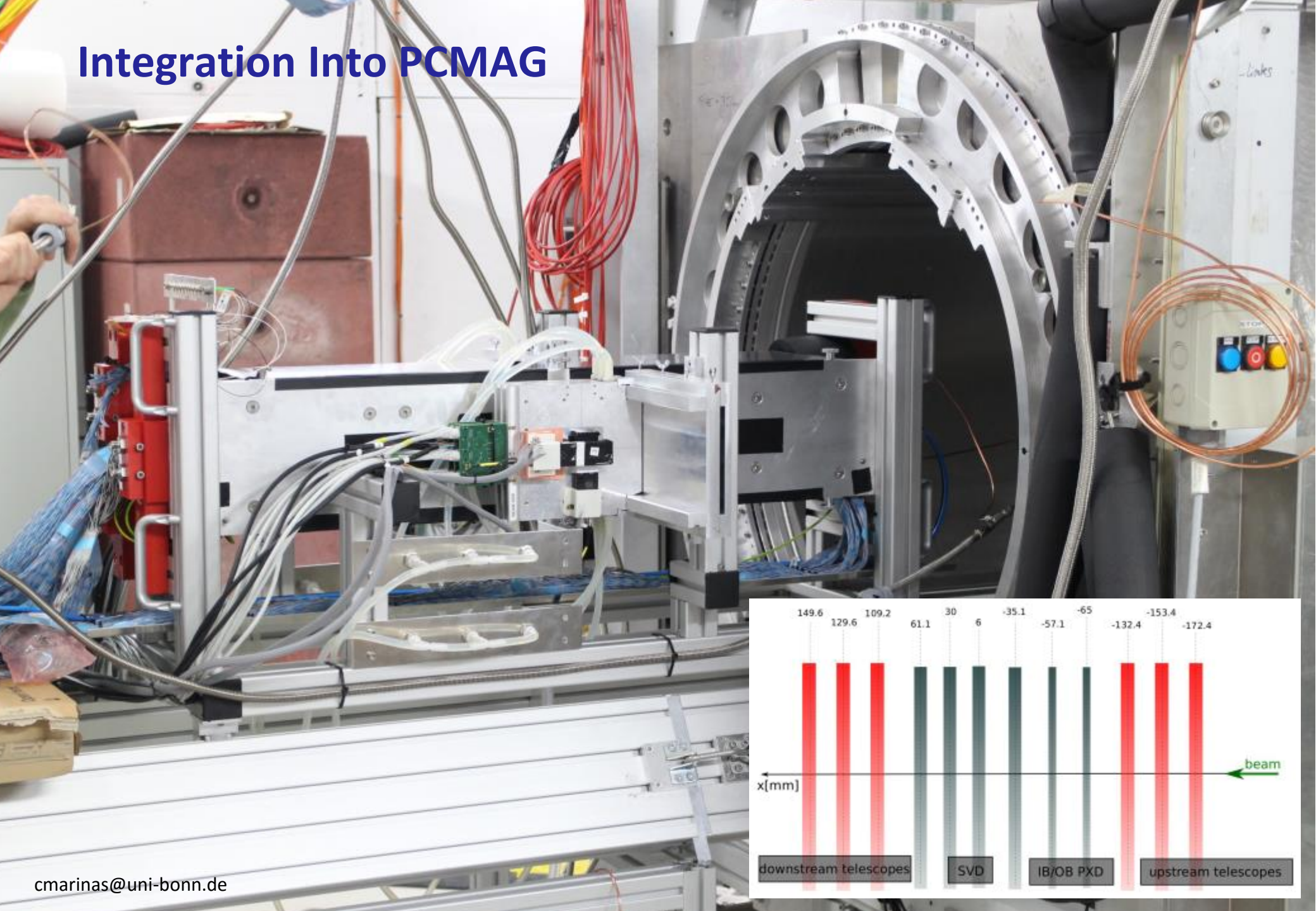
Strip Detector

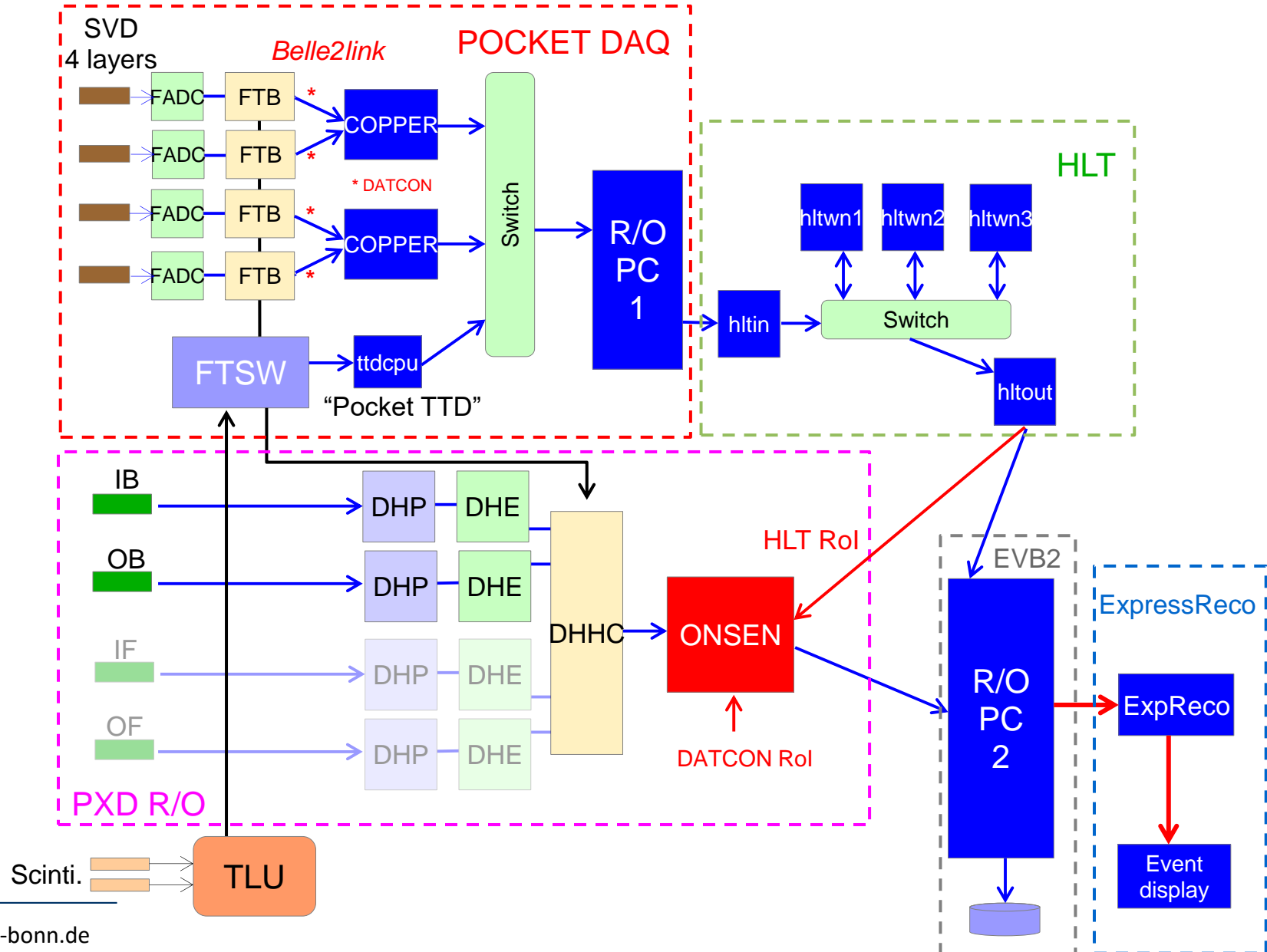


Belle II Vertex Detector

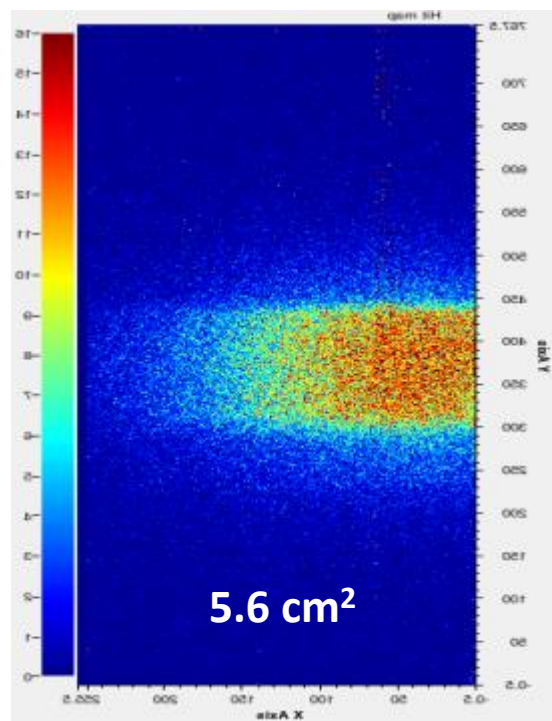


Integration Into PCMAG

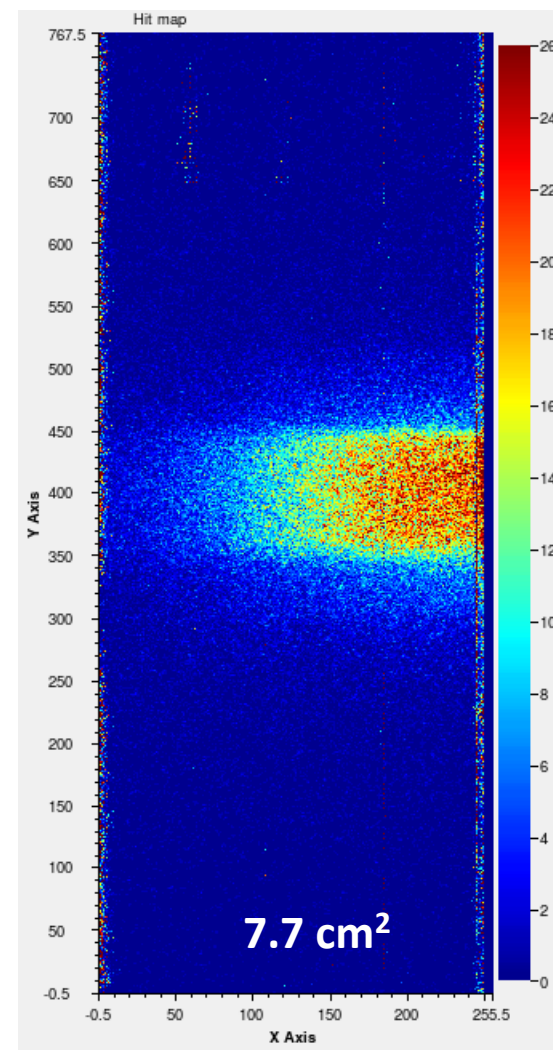




Threshold = 5 (~ 1200 electrons)

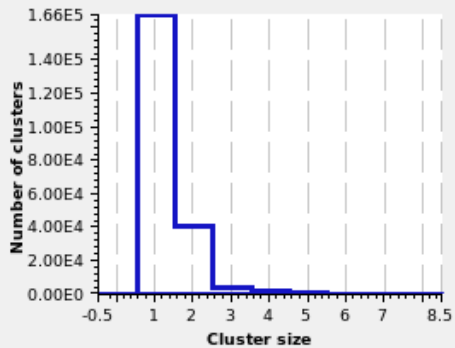
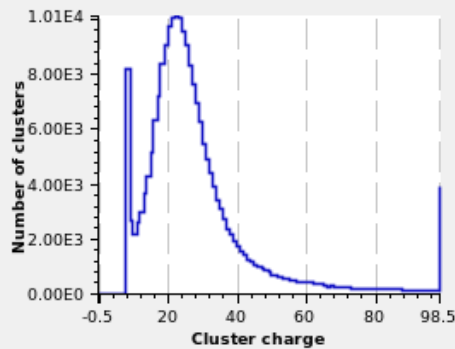
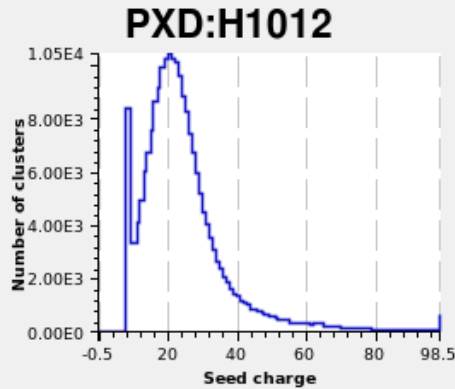


Inner Backward

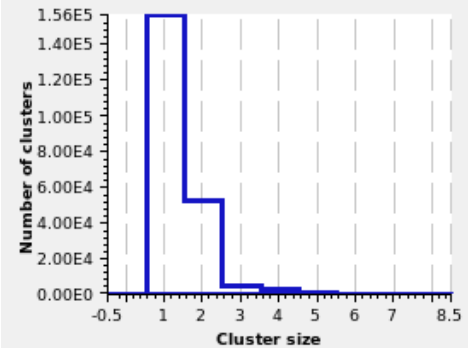
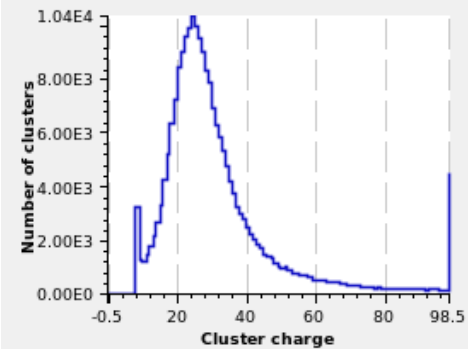
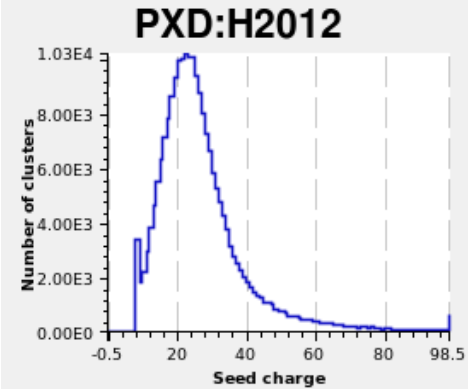


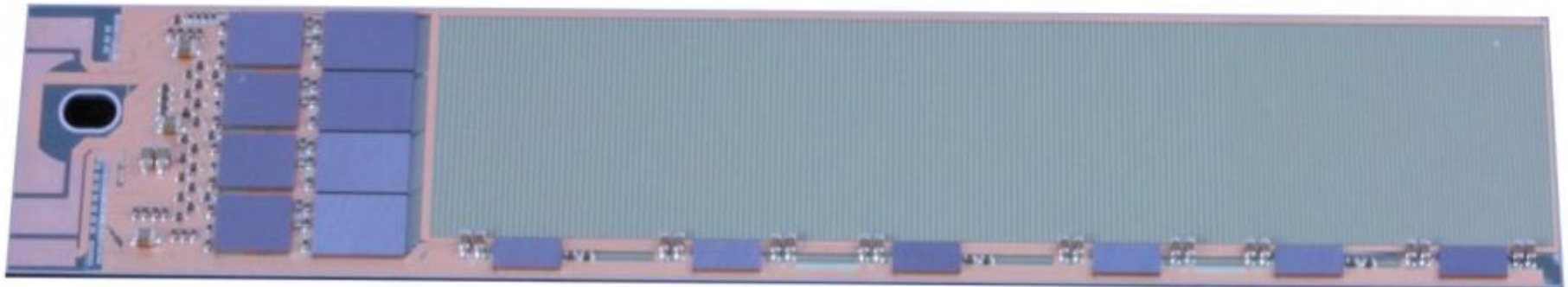
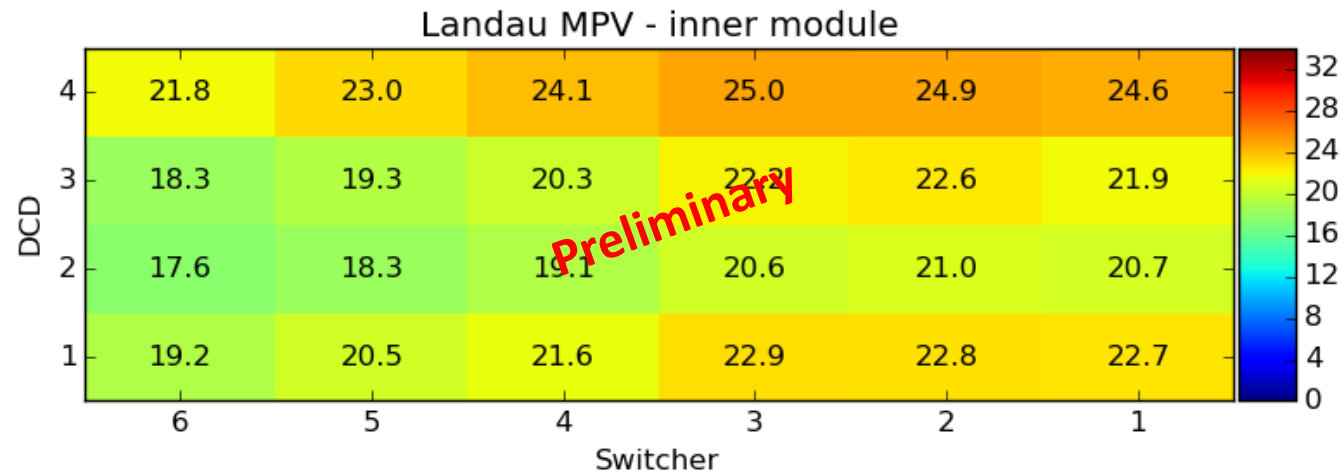
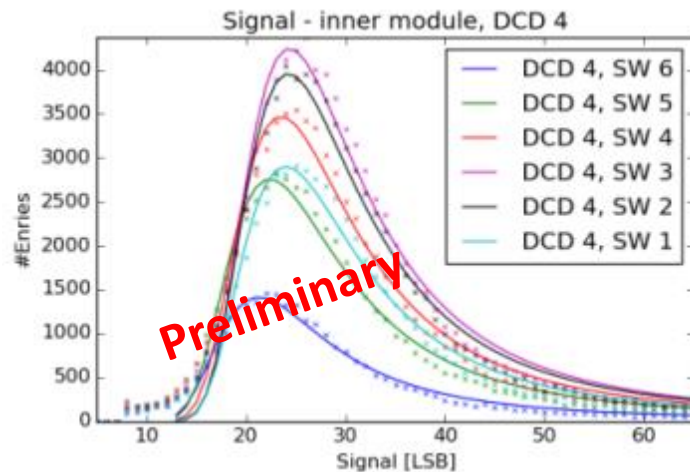
Outer Backward

Trigger on 4 scintillators
Collimated beam
No magnetic field



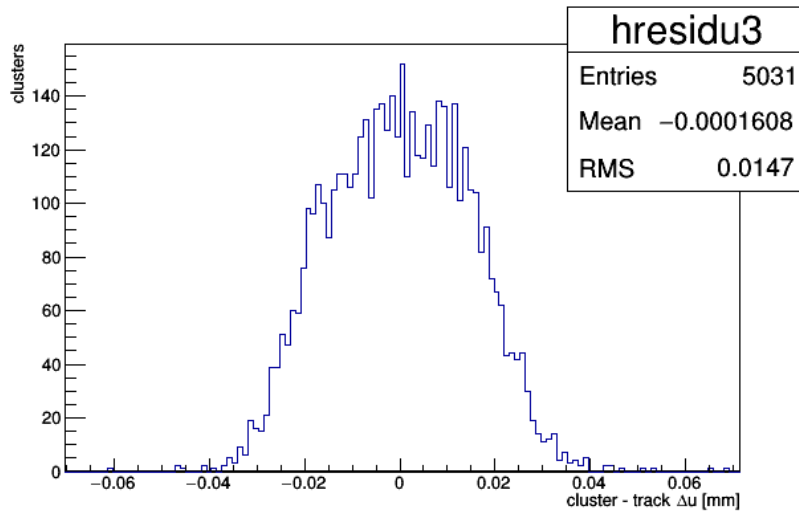
SNR ~ 32 for
perpendicular
incident MIPs





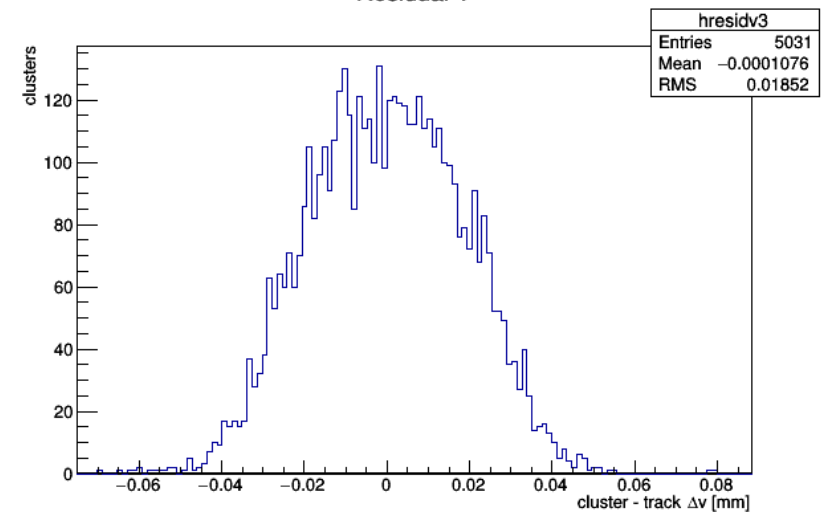
- The response from the matrix is rather uniform even without tuning. Modules just worked using operating parameters from Hybrid 5
- There is lot of room for improvements with better optimization of voltages and ASICs

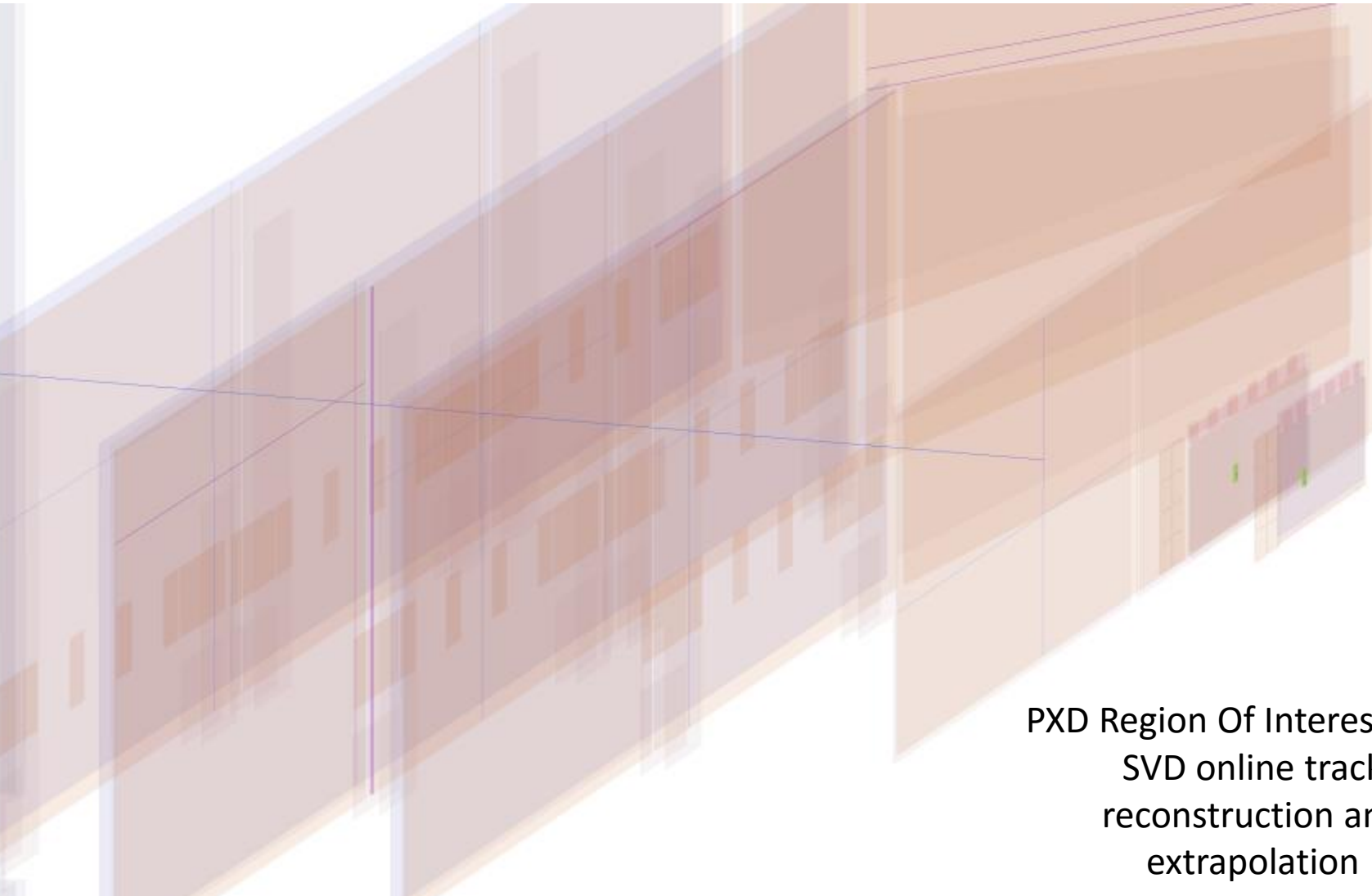
Residual U



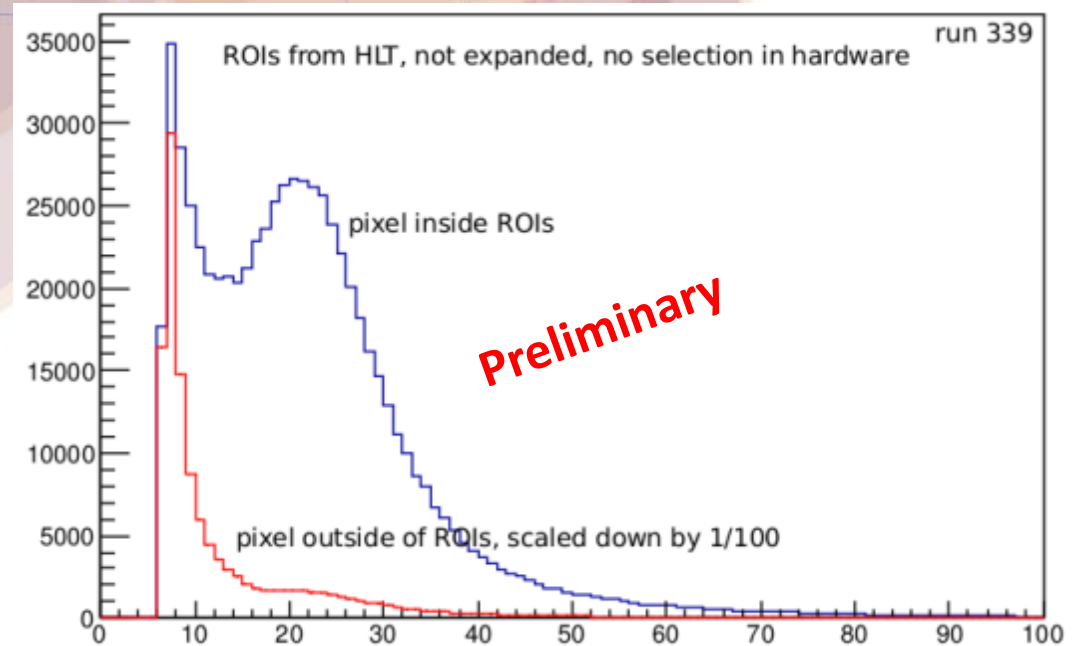
15 μm (18 μm)
for perpendicular
incident MIPs

Residual V

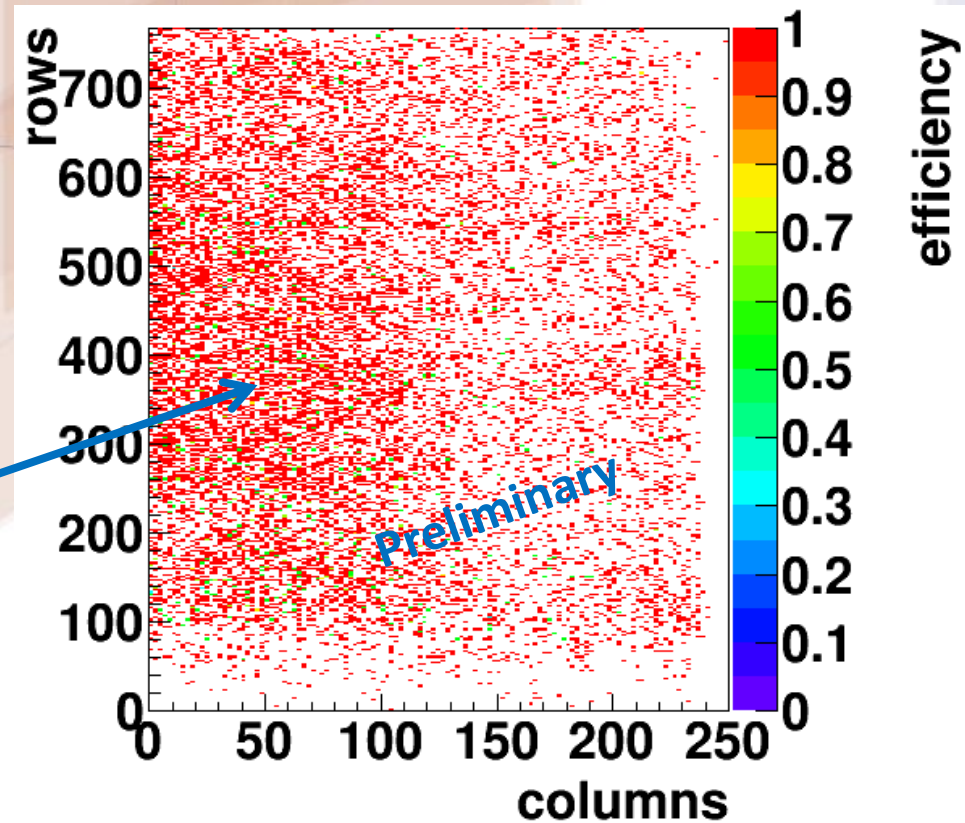


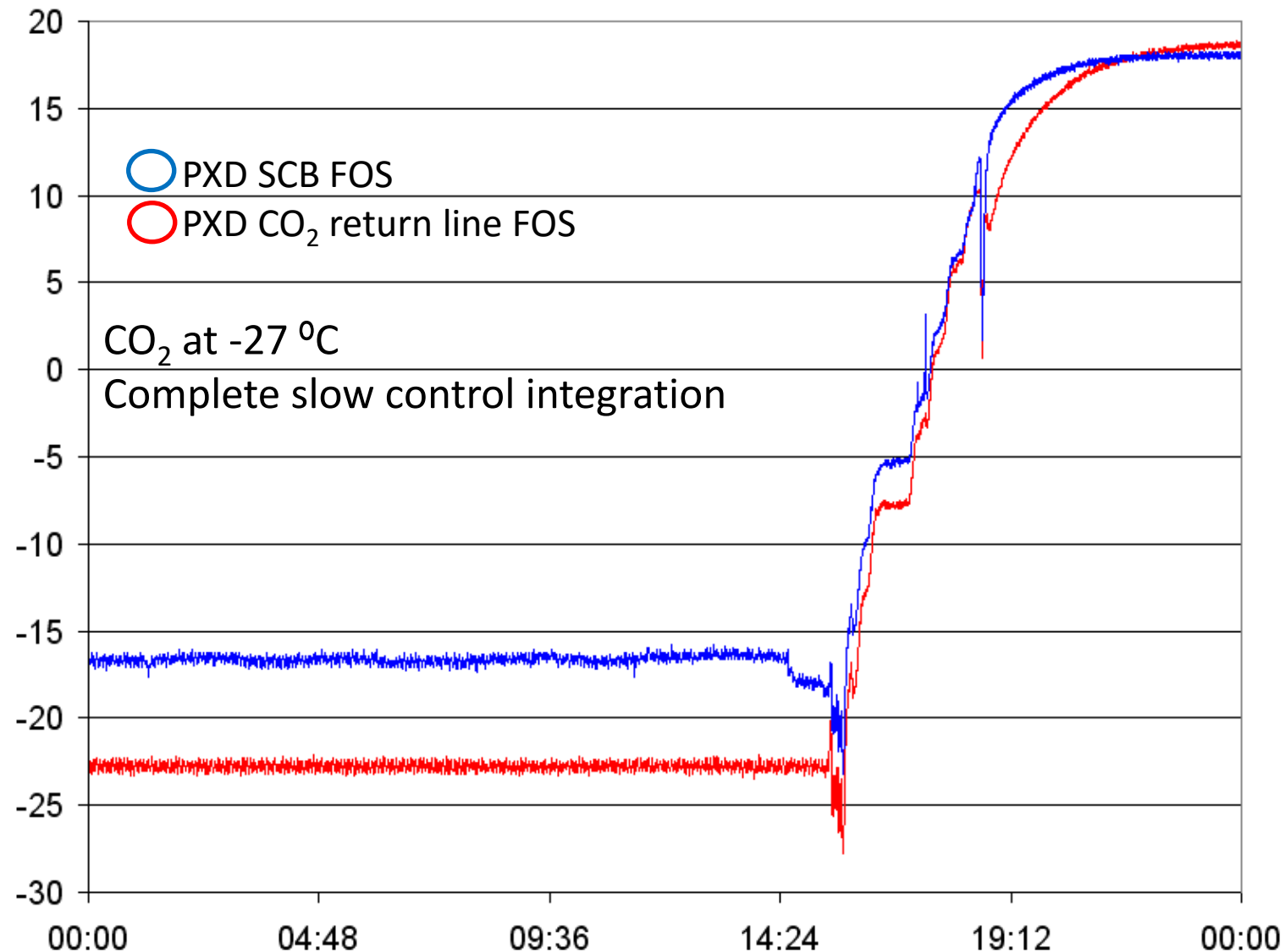


PXD Region Of Interest using
SVD online track
reconstruction and
extrapolation



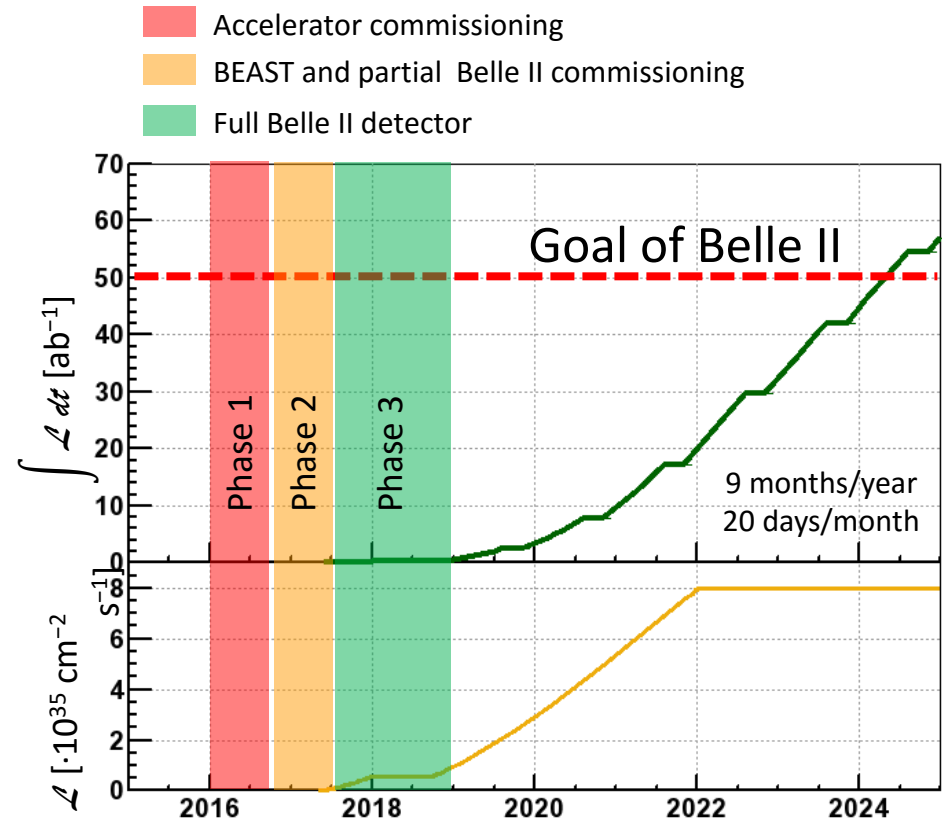
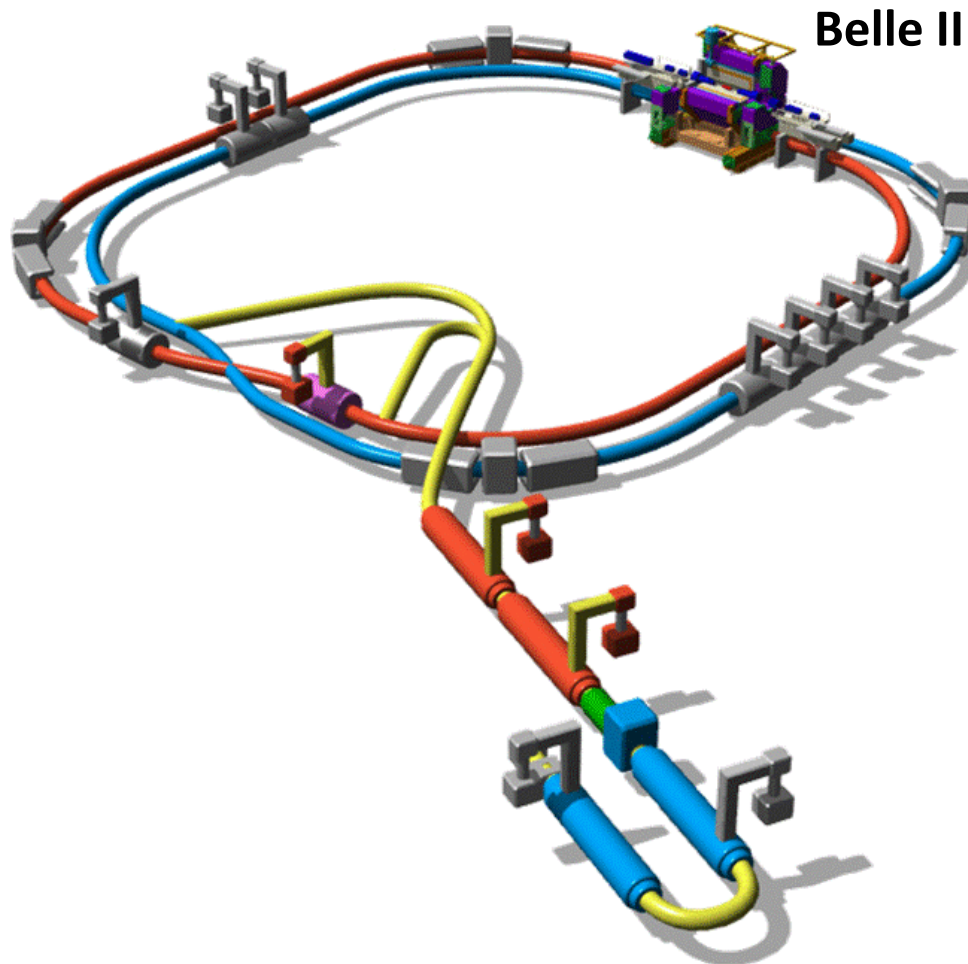
Product of: ROI selection efficiency
and detector efficiency





- Detectors fully operational: 'Final' Phase 2 hardware
- Hitmaps as expected in all layers. SNR OK
- PXD residuals according to specs
- Interdetector correlations (mapping and timing)
- Online data reduction
- 7 kHz 'artificial' trigger rate for 1 hour
- Few hours 2 kHz steady data acquisition
- Alignment
- Noise immunity studies → No interference observed
- Start/Stop fully controlled by master Run Control
- Environmental monitoring mostly integrated into EPICS
- Operation under realistic environmental conditions (CO_2 @ -27°C)

The SuperKEKB Accelerator



→ The fun is about to start!



Thanks